## Synchronous Buck Converter, Programmable Multiphase, with I<sup>2</sup>C Interface

The ADP4000 is an integrated power control IC with an  $I^2C$  interface. The ADP4000 can be programmed for 1-, 2-, 3-, 4-, 5- or 6phase operation, allowing for the construction of up to <u>six</u> complementary buck switching stages. The ADP4000 supports PSI, which is a power state indicator and can be used to reduce number of operating phases at light loads. The ADP4000 includes an  $I^2C$  interface, which can be used to program system set points such as voltage offset, load line, phase balance and output voltage. Key system performance data such as CPU current, CPU voltage, and power and fault conditions can also be read back over the  $I^2C$  interface from the ADP4000.

#### Features

- I<sup>2</sup>C Interface
- Supports Both VR11 and VR11.1 Specifications
- Digitally Programmable 0.375 V to 1.6 V Output
- Additional 200 mV Offset Programmable (Max 1.8 V Output)
- Selectable 1-, 2-, 3-, 4-, 5-, or 6-Phase Operation
- Fast-Enhanced PWM FlexMode<sup>™</sup>
- TRDET to Improve Load Release
- Active Current Balancing Between All Output Phases
- Supports On-The-Fly (OTF) VID Code Changes
- Supports **PSI** Power Saving Mode
- This is a Pb–Free Device

#### **Typical Applications**

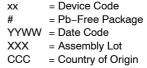
- Servers
- Desktop PC's
- POLs (Memory)

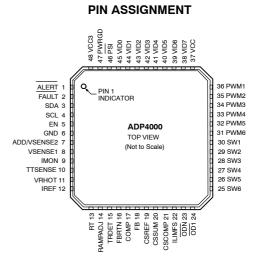


## **ON Semiconductor®**

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#### **ORDERING INFORMATION**

| Device*          | Package | Shipping <sup>†</sup> |
|------------------|---------|-----------------------|
| ADP4000JCPZ-REEL | LFCSP48 | 2500/Tape & Reel      |
| ADP4000JCPZ-RL7  | LFCSP48 | 750/Tape & Reel       |

\*The "Z' suffix indicates Pb-Free package.

<sup>+</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

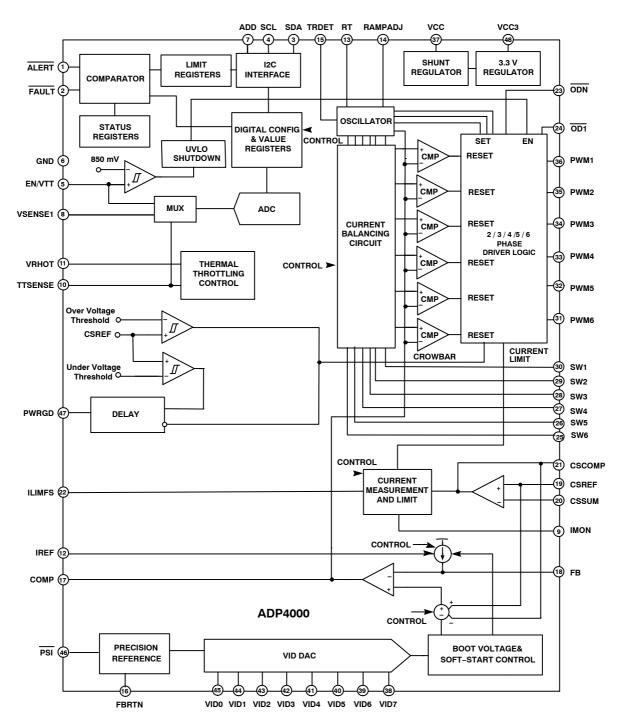


Figure 1. Block Diagram

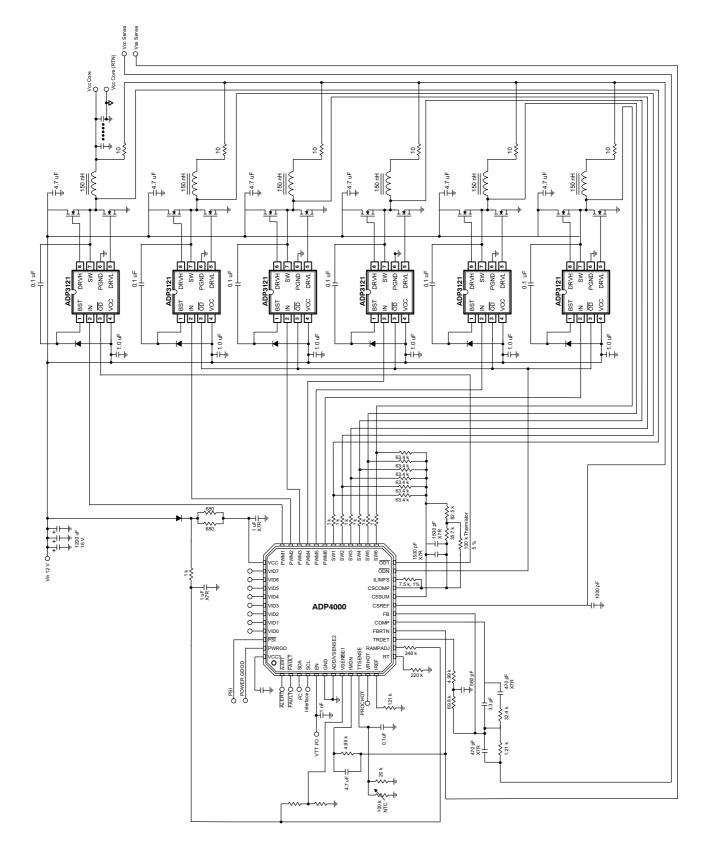


Figure 2. Application Schematic

#### **ABSOLUTE MAXIMUM RATINGS**

| Rating  | Symbol             | Value                         | Unit |
|---|--------------------|-------------------------------|------|
| Input Voltage Range (Note 1)  | V <sub>IN</sub>    | –0.3 to 6                     | V    |
| FBRTN   | V <sub>FBRTN</sub> | -0.3 to + 0.3                 | V    |
| PWM2 to PWM6, Rampadj   |                    | –0.3 to V <sub>IN</sub> + 0.3 | V    |
| SW1 to SW6  |                    | -5 to +25                     | V    |
| SW1 to SW6 (<200 ns )   |                    | -10 to +25                    | V    |
| All other Inputs and Outputs  |                    | –0.3 to V <sub>IN</sub> + 0.3 | V    |
| Storage Temperature Range   | TSTG               | –65 to 150                    | °C   |
| Operating Ambient Temperature Range   |                    | 0 to 85                       | °C   |
| ESD Capability, Human Body Model (Note 2)   | ESD <sub>HBM</sub> | 2                             | kV   |
| ESD Capability, Machine Model (Note 2)  | ESD <sub>MM</sub>  | 100                           | V    |
| Moisture Sensitivity Level  | MSL                | 3                             | -    |
| Lead Temperature Soldering<br>Reflow (SMD Styles Only), Pb–Free Versions (Note 3) | T <sub>SLD</sub>   | 260                           | °C   |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. Refer to Electrical Characteristics and Application Information for Safe Operating Area.

2. This device series incorporates ESD protection and is tested by the following methods:

ESD Human Body Model tested per ÁEC–Q100–002 (EIA/JESĎ22–A114) ESD Machine Model tested per ÁEC–Q100–003 (EIA/JESD22–A115) Latchup Current Maximum Rating: ≤150 mA per JEDEC standard: JESD78

3. For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

#### THERMAL CHARACTERISTICS

| Characteristic  | Symbol                          | Value    | Unit |
|---|---------------------------------|----------|------|
| Thermal Characteristics, LFCSP, 7 mm * 7 mm (Note 1)<br>Thermal Resistance, Junction-to-Air (Note 4)<br>Thermal Resistance, Junction-to-Lead 2 (Note 4) | $R_{	heta JA}$<br>$R_{\Psi JL}$ | 24<br>10 | °C/W |

4. Values based on copper area of 645 mm<sup>2</sup> (or 1 in<sup>2</sup>) of 1 oz copper thickness and FR4 PCB substrate.

#### **OPERATING RANGES** (Note 1)

| Characteristic                                    | Symbol           | Min   | Max | Unit |
|---|------------------|-------|-----|------|
| Output Voltage (Adjustable Version Only) (Note 5) | V <sub>OUT</sub> | 0.375 | 1.8 | V    |
| Ambient Temperature                               | T <sub>A</sub>   | 0     | 85  | °C   |

5. Maximum limit for  $V_{OUT} = V_{OUT(NOM)} - 10\%$ .

## **PIN ASSIGNMENT**

| Pin No.  | Pin Name        | Description   |  |  |  |  |
|----------|-----------------|---|--|--|--|--|
| 1        | ALERT           | ALERT Output. Open drain output that asserts low when the VR exceeds a programmable limit.  |  |  |  |  |
| 2        | FAULT           | FAULT Output. Open drain output that asserts low when a fault has occurred. This fault can be due to VR or current limit, crowbar, or undervoltage. The trip points are loaded into registers.  |  |  |  |  |
| 3        | SDA             | Digital Input Output. I <sup>2</sup> C serial data bidirectional pin. Requires pullup.  |  |  |  |  |
| 4        | SCL             | Digital Input. I <sup>2</sup> C serial bus clock open drain input. Requires pullup.   |  |  |  |  |
| 5        | EN              | Power Supply Enable Input. Pulling this pin to GND disables the PWM outputs and pulls the PWRGD output low.   |  |  |  |  |
| 6        | GND             | und. All internal biasing and the logic output signals of the device are referenced to this ground.   |  |  |  |  |
| 7        | ADD/<br>VSENSE2 | I <sup>2</sup> C Address Input. Connect a resistor to ground to select one of 8 addresses. This input is reconfigured after startup as an analog voltage monitor, VSENSE2.  |  |  |  |  |
| 8        | VSENSE1         | Analog Input. Measures an input voltage between 0 and 2.0 V and reports this back over the I <sup>2</sup> C interface.  |  |  |  |  |
| 9        | IMON            | Total Current Output Pin.   |  |  |  |  |
| 10       | TTSENSE         | VR Temperature Sense Input. An NTC thermistor between this pin and GND is used to remotely sense the temperature at the desired thermal monitoring point.   |  |  |  |  |
| 11       | VRHOT           | VR HOT Output. Open drain output that signals when the temperature at the monitoring point connected to TTSENSE exceeds the VRHOT temperature threshold.  |  |  |  |  |
| 12       | IREF            | Current Reference Input. An external resistor from this pin to ground sets the reference current for IFB, IILIMFS, and ITH(X).  |  |  |  |  |
| 13       | RT              | Frequency Setting Resistor Input. An external resistor connected between this pin and GND sets the oscillator frequency of the device.  |  |  |  |  |
| 14       | RAMPADJ         | PWM Ramp Current Input. An external resistor from the converter input voltage to this pin sets the internal PWM ramp.   |  |  |  |  |
| 15       | TRDET           | Transient Detect. This output is asserted low whenever a load release is detected   |  |  |  |  |
| 16       | FBRTN           | Feedback Return. VID DAC and error amplifier reference for remote sensing of the output voltage.  |  |  |  |  |
| 17       | COMP            | Error Amplifier Output and Compensation Point.  |  |  |  |  |
| 18       | FB              | Feedback Input. Error amplifier input for remote sensing of the output voltage. An external resistor between this pin and the output voltage sets the no load offset point.   |  |  |  |  |
| 19       | CSREF           | Current Sense Reference Voltage Input. The voltage on this pin is used as the reference for the current sense amplifier and the Power–Good and crowbar functions. This pin should be connected to the common point of the output inductors.   |  |  |  |  |
| 20       | CSSUM           | Current Sense Summing Node. External resistors from each switch node to this pin sum the average inductor currents together to measure the total output current.  |  |  |  |  |
| 21       | CSCOMP          | Current Sense Compensation Point. A resistor and capacitor from this pin to CSSUM determines the gain of the current sense amplifier and the positioning loop response time.  |  |  |  |  |
| 22       | ILIMFS          | Current Sense and Limit Scaling Pin. An external resistor from this pin to CSCOMP sets the internal current sensing signal for current limit and IMON. This value can be over-written using I <sup>2</sup> C interface.   |  |  |  |  |
| 23       | ODN             | Output Disable Logic Output for $\overline{PSI}$ operation. This pin is actively pulled low when $\overline{PSI}$ is low, otherwise it functions in the same way as $\overline{DD1}$ .  |  |  |  |  |
| 24       | OD1             | Output Disable Logic Output. This pin is actively pulled low when the EN input is low or when $V_{CC}$ is below its UVLO threshold to signal to the Driver IC that the driver high-side and low-side outputs should go low.   |  |  |  |  |
| 25 to 30 | SW6 to<br>SW1   | Current Balance Inputs. Inputs for measuring the current level in each phase. The SW pins of unused phases should be left open.   |  |  |  |  |
| 31 to 36 | PWM6 to<br>PWM1 | Logic–Level PWM Outputs. Each output is connected to the input of an external MOSFET driver such as the ADP3121. Connecting PWM6 to $V_{CC}$ disables PWM6, connecting PWM5 to $V_{CC}$ disables PWM5 and PWM6, etc. This means the ADP4000 can be setup to operate as a 1–2–, 3–, 4–, 5–, or 6–phase controller. |  |  |  |  |
| 37       | VCC             | Supply Voltage for the Device. A 340 $\Omega$ resistor should be placed between the 12 V system supply and the V <sub>CC</sub> pin. The internal shunt regulator maintains V <sub>CC</sub> = 5.0 V.   |  |  |  |  |
| 38 to 45 | VID7 to<br>VID0 | Voltage Identification DAC Inputs. These eight pins are pulled down to GND, providing a logic zero if left open. When in normal operation mode, the DAC output programs the FB regulation voltage from 0.375 V to 1.6 V.  |  |  |  |  |
| 46       | PSI             | Power State Indicator. Pulling this pin low places the controller in lower power state operation.   |  |  |  |  |
| 47       | PWRGD           | Power–Good Output. Open–drain output that signals when the output voltage is outside of the proper<br>operating range.  |  |  |  |  |
| 48       | VCC3            | 3.3 V Power Supply Output. A capacitor from this pin to ground provided decoupling for the interval 3.3 V LDO.  |  |  |  |  |

#### **ELECTRICAL CHARACTERISTICS**

 $V_{IN}$  = (5.0 V) FBRTN – GND, for typical values  $T_A$  = 25°C, for min/max values  $T_A$  = 0°C to 85°C; unless otherwise noted. (Notes 1 and 2)

| Parameter                               | Test Conditions  | Symbol                   | Min   | Тур               | Max   | Unit |
|---|--|--------------------------|-------|-------------------|-------|------|
| Reference Current                       |  | •                        |       |                   |       | -    |
| Reference Bias Voltage                  |  | VIREF                    | 1.75  | 1.8               | 1.85  | V    |
| Reference Bias Current                  | R <sub>IREF</sub> = 121 kΩ   | I <sub>IREF</sub>        |       | 15                |       | μA   |
| Error Amplifier                         |  | •                        |       |                   |       |      |
| Output Voltage Range                    |  | V <sub>COMP</sub>        | 0     |                   | 4.4   | V    |
| Accuracy                                | Relative to nominal DAC output, referenced   | V <sub>FB</sub>          | -7    |                   | +7    | mV   |
|   | to FBRTN (see Figure 2)<br>In startup  | V <sub>FB(BOOT)</sub>    | 1.093 | 1.1               | 1.107 | v    |
| Load Line Positioning Accuracy          | · · · · · · · · · · · · · · · · · · ·  | 10(0001)                 | -77   | -80               | -83   | mV   |
| Load Line Range                         |  |                          | -350  |                   | 0     | mV   |
| Load Line Attenuation                   |  |                          | 0     |                   | 100   | %    |
| Differential Non-linearity              |  |                          | -1.0  |                   | +1.0  | LSB  |
| Input Bias Current                      |  | I <sub>FB</sub>          | 14.2  | 16                | 17.7  | μA   |
| Offset Accuracy                         | VR Offset Register = 111111, VID = 1.0 V   |                          |       | -193.75           |       | mV   |
| ,                                       | VR Offset Register = 011111, VID = 1.0 V   |                          |       | 193.75            |       |      |
| FBRTN Current                           |  | I <sub>FBRTN</sub>       |       | 100               | 200   | μA   |
| Output Current                          | FB forced to V <sub>OUT</sub> -3%  | I <sub>COMP</sub>        |       | 500               |       | μA   |
| Gain Bandwidth Product                  | COMP = FB  | GBW <sub>(ERR)</sub>     |       | 20                |       | MHz  |
| Slew Rate                               | COMP = FB  |                          |       | 25                |       | V/μs |
| BOOT Voltage Hold Time                  | Internal Timer   | t <sub>BOOT</sub>        |       | 2.0               |       | ms   |
| VID Inputs                              |  | -                        |       | -                 |       | -    |
| Input Low Voltage                       | VID(X)   | V <sub>IL(VID)</sub>     |       |                   | 0.3   | V    |
| Input High Voltage                      | VID(X)   | V <sub>IH(VID)</sub>     | 0.8   |                   |       | V    |
| Input Current                           |  | I <sub>IN(VID)</sub>     |       | -5.0              |       | μA   |
| VID Transition Delay Time               | VID code change to FB change   |                          | 200   |                   |       | ns   |
| No CPU Detection Turn-Off Delay<br>Time | VID code change to PWM going low   |                          | 5.0   |                   |       | μs   |
| Oscillator                              |  | -                        |       | -                 |       | -    |
| Frequency Range                         |  | f <sub>OSC</sub>         | 0.25  |                   | 9.0   | MHz  |
| Frequency Variation                     | $\begin{array}{l} T_{A}=25^{\circ}C,\ R_{T}=\ 270\ k\Omega,\ 6-phase\\ T_{A}=25^{\circ}C,\ R_{T}=\ 130\ k\Omega,\ 6-phase\\ T_{A}=25^{\circ}C,\ R_{T}=\ 68\ k\Omega,\ 6-phase \end{array}$ | <b>f</b> PHASE           | 225   | 245<br>500<br>850 | 265   | kHz  |
| Output Voltage                          | RT = 500 k $\Omega$ to GND   | V <sub>RT</sub>          | 1.93  | 2.03              | 2.13  | V    |
| RAMPADJ Output Voltage                  | RAMPADJ – FB, V <sub>FB</sub> = 1.0 V,<br>IRAMPADJ = –150 μA   | V <sub>RAMPADJ</sub>     | -50   |                   | +50   | mV   |
| RAMPADJ Input Current Range             |  | I <sub>RAMPADJ</sub>     | 5.0   |                   | 60    | μΑ   |
| Current Sense Amplifier                 |  |                          |       |                   |       |      |
| Offset Voltage                          | CSSUM – CSREF (see Figure 4)   | V <sub>OS(CSA)</sub>     | -1.0  | 0                 | +1.0  | mV   |
| Input Bias Current, CSREF               | CSREF = 1.0 V  | I <sub>BIAS(CSREF)</sub> | -20   |                   | +20   | μA   |
| Input Bias Current, CSSUM               | CSREF = 1.0 V  | IBIAS(CSSUM)             | -10   |                   | +10   | nA   |
| Gain Bandwidth Product                  | CSSUM = CSCOMP   | GBW <sub>(CSA)</sub>     |       | 10                |       | MHz  |
| Current Sense Amplifier                 |  |                          |       |                   |       |      |
| Slew Rate                               | C <sub>CSCOMP</sub> = 10 pF  |                          |       | 10                |       | V/μs |
| Input Common-Mode Range                 | CSSUM and CSREF  |                          | 0     |                   | 3.0   | V    |
| Output Voltage Range                    |  |                          | 0.05  |                   | 3.0   | V    |
| Output Current                          |  | ICSCOMP                  |       | 500               |       | μΑ   |

Refer to Absolute Maximum Ratings and Application Information for Safe Operating Area.
 Guaranteed by design, not production tested.

#### **ELECTRICAL CHARACTERISTICS**

 $V_{IN} = (5.0 \text{ V}) \text{ FBRTN} - \text{GND}$ , for typical values  $T_A = 25^{\circ}\text{C}$ , for min/max values  $T_A = 0^{\circ}\text{C}$  to  $85^{\circ}\text{C}$ ; unless otherwise noted. (Notes 1 and 2)

| Parameter                              | Test Conditions   | Symbol                 | Min  | Тур  | Max  | Unit |
|--|---|------------------------|------|------|------|------|
| PSI                                    |   |                        |      |      |      |      |
| Input Low Voltage                      |   |                        |      |      | 0.3  | V    |
| Input High Voltage                     |   |                        | 0.8  |      |      | V    |
| Input Current                          |   |                        |      | -5   |      | μΑ   |
| Assertion Timing                       | Fsw = 300kHz  |                        |      | 3.3  |      | μs   |
| Deassertion Timing                     | Fsw = 300kHz  |                        |      |      | 825  | ns   |
| TRDET                                  |   |                        |      |      |      |      |
| Output Low Voltage                     | I <sub>OUT</sub> = -6 mA  | V <sub>OL</sub>        |      | 150  | 300  | mV   |
| IMON                                   |   | -                      |      |      | -    | -    |
| Clamp Voltage                          |   |                        | 1.0  |      | 1.15 | V    |
| Accuracy                               | 10 x (CSREF – CSCOMP)/R <sub>ILIM</sub>   |                        | -3.0 |      | 3.0  | %    |
| Output Current                         |   |                        |      |      | 800  | μA   |
| Offset                                 |   |                        | -5.5 |      | 5.5  | mV   |
| Current Limit Comparator               |   |                        |      |      |      |      |
| I <sub>LIM</sub> Bias Current          | $\begin{array}{l} \mbox{CSREF} - \mbox{CSCOMP})/\mbox{R}_{ILIM}, \\ \mbox{(CSREF} - \mbox{CSCOMP}) = 150 \mbox{ mV}, \mbox{R}_{ILIM} = 7.5 \mbox{ k}\Omega \end{array}$ | I <sub>LIM</sub>       |      | 22   |      | μΑ   |
| Current Limit Threshold Current        | 4/3 x I <sub>IREF</sub>   | I <sub>CL</sub>        |      | 22   |      | μA   |
| Current Balance Amplifier              |   |                        |      |      |      |      |
| Common-Mode Range                      |   | V <sub>SW(X)CM</sub>   | -600 |      | +200 | mV   |
| Input Resistance                       | SW(X) = 0 V   | R <sub>SW(X)</sub>     | 12   | 18   | 21   | kΩ   |
| Input Current                          | SW(X) = 0 V   | I <sub>SW(X)</sub>     | 8.0  | 12   | 18   | μΑ   |
| Input Current Matching                 | SW(X) = 0 V   | $\Delta I_{SW(X)}$     | -6.0 |      | +6.0 | %    |
| Phase Balance Adjustment Range Low     | Phase Bal Registers = 00000   |                        |      | -25  |      | %    |
| Phase Balance Adjustment Range<br>High | Phase Bal Registers = 11111   |                        |      | +25  |      | %    |
| Delay Timer                            |   |                        |      |      |      |      |
| Internal Timer                         | Delay Time Register = 011   |                        |      | 2.0  |      | ms   |
| Timer Range Low                        | Delay Time Register = 000   |                        |      | 0.5  |      | ms   |
| Timer Range High                       | Delay Time Register = 111   |                        |      | 4.0  |      | ms   |
| Soft-Start                             |   |                        |      |      |      |      |
| Internal Timer                         | Soft-Start Slope Register = 010   |                        |      | 0.5  |      | V/ms |
| Timer Range Low                        | Soft-Start Slope Register = 000   |                        |      | 0.1  |      | V/ms |
| Timer Range High                       | Soft-Start Slope Register = 111   |                        |      | 1.5  |      | V/ms |
| Enable Input                           |   |                        |      |      |      |      |
| Input Low Voltage                      |   | V <sub>IL(EN)</sub>    |      |      | 0.3  | V    |
| Input High Voltage                     |   | V <sub>IH(EN)</sub>    | 0.8  |      |      | V    |
| Input Current                          |   | I <sub>IN(EN)</sub>    |      | -1.0 |      | μΑ   |
| Delay Time                             | EN > 0.8 V, Internal Delay  | t <sub>DELAY(EN)</sub> |      | 2.0  |      | ms   |
| ODN and OD1 Outputs                    |   |                        |      |      |      |      |
| Output Low Voltage                     | I <sub>OD(SINK)</sub> = -400 μA   | V <sub>OL(ODN/1)</sub> |      | 160  | 500  | mV   |
| Output High Voltage                    | I <sub>OD(SOURCE)</sub> = 400 μA  | V <sub>OL(ODN/1)</sub> | 4.0  | 5.0  |      | V    |
| ODN / OD1 Pulldown Resistor            |   |                        |      | 60   |      | kΩ   |

Refer to Absolute Maximum Ratings and Application Information for Safe Operating Area.
 Guaranteed by design, not production tested.

#### **ELECTRICAL CHARACTERISTICS**

 $V_{IN} = (5.0 \text{ V}) \text{ FBRTN} - \text{GND}$ , for typical values  $T_A = 25^{\circ}\text{C}$ , for min/max values  $T_A = 0^{\circ}\text{C}$  to  $85^{\circ}\text{C}$ ; unless otherwise noted. (Notes 1 and 2)

| Power-Good Comparator         Undervoltage Afustment Range Low         Relative to Nominal DAC Output         VPWRGD (L)         -600         -600         mV           Undervoltage Adjustment Range High         PWRGD (L) Register - 101         C         -150         C         mV           Overvoltage Adjustment Range High         PWRGD (L) Register - 111         C         100         200         300         400         mV           Overvoltage Adjustment Range High         PWRGD (L) Register - 10         VPWRGD (L) Register - 10         100         200         300         MV           Overvoltage Adjustment Range High         PWRGD (L) Register - 10         C         100         200         100         MV           Output Low Voltage         Immani Dirac Adjustment Range High         PWRGD (L) Register - 10         C         100         200         100  | Parameter                          | Test Conditions                       | Symbol                            | Min  | Тур  | Max  | Unit |
|---|------------------------------------|---------------------------------------|-----------------------------------|------|------|------|------|
| Undervoltage Adjustment Range Low         PWRGD_LO Register = 111        500         mV           Overvoltage Adjustment Range High         PWRGD_LO Register = 111        500         mV           Overvoltage Adjustment Range Low         PWRGD_HI Register = 00        500         mV           Overvoltage Adjustment Range Low         PWRGD_HI Register = 00        500         mV           Overvoltage Adjustment Range Low         PWRGD_HI Register = 00        500         mV           Output Low Voltage         IpvRGD_SINQ = -4 mA         Vol.pvRGD         150         300         mV           During Soft-Start         Internal Timer        20         ms         sist         ms           VID Code Statis         Relative to DAC Output, PWRGD_HI = 00         VCROWEMR         200         300         400         mV           Crowbar Trip Point         Relative to DAC Output, PWRGD_HI = 00         VCROWEMR         200         300         mV           Crowbar Statis         Relative to DAC Output, PWRGD_HI = 00         VCROWEMR         200         300         mV           Crowbar Statis         Relative to FBRTN         250         300         300         mV           Crowbar Statis         Relative to FBRTN         250         300         mV         mV  | Power–Good Comparator              |                                       |                                   |      |      |      |      |
| Undervoltage Adjustment Range High         PWRGD_LO Register = 111         -150         mV           Overvoltage Threshold         Relative to DAC Output, PWRGD_Hi = 00         VPWRGD(VV)         200         300         400         mV           Overvoltage Adjustment Range Low         PWRGD_Hi Register = 11         -         150         mV           Overvoltage Adjustment Range High         PWRGD_Hi Register = 00         300         mV         mV           Output Low Voltage         Inversorts         150         300         mV           Power Good Delay Time         -         2.0         ms         T           VID Code Changing         -         2.0         ms         T         2.00         ms           VID Code Static         Netarity Forint         Relative to DAC Output, PWRGD_Hi = 00         V_CACWBAR         2.0         300         mV           Crowbar Adjustment Range         PWRGD_Hi Register         150         300         mV         Crowbar Adjustment Range         PWRGD_Hi Register         150         300         mV           Crowbar Adjustment Range         PWRGD_Hi Register         100         250         µs         VIC Code Changing         100         250         µs           VID Code Changing         -         400   | Undervoltage Threshold             | Relative to Nominal DAC Output        | V <sub>PWRGD(UV)</sub>            | -600 | -500 | -400 | mV   |
| Overvoltage Threshold         Relative to DAC Output, PWRGD_HI = 00         VPWRGD_WRGD_WRGD_WRGD_WRGD_WRGD_WRGD         200         300         400         mV           Overvoltage Adjustment Range Low         PWRGD_HI Register = 11          150         300         mV           Output Low Voltage         IewRGD_WRGD_HI Register = 00          300         mV           Output Low Voltage         IewRGD_WI Register = 01          200         ms           During Soft-Start         Internal Timer          2.0          ms           VID Code Changing          100         250          ms           VID Code Static           2.00          ms           Crowbar Adjustment Range         PWRGD_HI Register          150         300         mV           Crowbar Adjustment Range         PWRGD_HI Register          150          300         mV           Crowbar Adjustment Range         PWRGD_HI Register          150           mV           Crowbar Adjustment Range         PWRGD_HI Register          150          mV           Crowbar Adjustment Range         PWRGD_HI Register   | Undervoltage Adjustment Range Low  | PWRGD_LO Register = 000               |                                   |      | -500 |      | mV   |
| Overvoltage Adjustment Range High         PWRGD_Hit Register = 00         In         150         mV           Overvoltage Adjustment Range High         PWRGD_HI Register = 00         in         300         mV           Output Low Voltage         IpwrgD_(BINK) = 4 mA         VoL(PWRDD)         150         300         mV           During Soft-Start         Internal Timer         Internal Timer         2.0         ms           VID Code Changing         Internal Timer         2.00         ins           Crowbar Trip Point         Relative to DAC Output, PWRGD_HI = 00         V <sub>CROWBAR</sub> 200         300         mV           Crowbar Adjustment Range         PWROD_HI Register         500         300         mV         700         300         mV           Crowbar Delay Time         Overvoltage to PWROD_HI Register         100         250         300         350         mV           VID Code State         Dovervoltage to PWR going low         V <sub>CROWBAR</sub> 100         250         µs           VID Code State         IpwMISINK) = -400 µA         VOL/PWMM         160         500         mV           Output Low Voltage         IpwMISINK) = -400 µA         VOL/PWMM         1.0         1.0         µs           Output Low Voltage <t< td=""><td>Undervoltage Adjustment Range High</td><td>PWRGD_LO Register = 111</td><td></td><td></td><td>-150</td><td></td><td>mV</td></t<>  | Undervoltage Adjustment Range High | PWRGD_LO Register = 111               |                                   |      | -150 |      | mV   |
| Overvoltage Adjustment Range High         PWRGD_Hi Register = 00         Image: Mark Stress S          | Overvoltage Threshold              | Relative to DAC Output, PWRGD_Hi = 00 | V <sub>PWRGD(OV)</sub>            | 200  | 300  | 400  | mV   |
| Output Low Voltage         IpWRGD(SINK) = -4 mÅ         VOL(PWRGD)         150         300         mV           Power Good Delay Time   <   | Overvoltage Adjustment Range Low   | PWRGD_Hi Register = 11                |                                   |      | 150  |      | mV   |
| Power Good Delay Time         Internal Timer         In         In         In         In           During Soft-Start         Internal Timer         In         2.0         Im         ms           VID Code Changing         In         In         In         2.0         Im         ms           VID Code Static         In         In         VID Code Static         In         In         VID Code Static   | Overvoltage Adjustment Range High  | PWRGD_Hi Register = 00                |                                   |      | 300  |      | mV   |
| During Soft-Start         Internal Timer         2.0         ms           VID Code Changing         100         250         μps           VID Code Static         100         250         μps           Crowbar Tip Point         Relative to DAC Output, PWRGD_Hi = 00         V <sub>CROWBAR</sub> 200         300         400         mv           Crowbar Adjustment Range         PWRGD_HI Register         150         300         400         mV           Crowbar Reset Point         Relative to FBRTN         250         300         350         mV           Crowbar Delay Time         Overvoltage to PWM going low         t <sub>CROWBAR</sub> 100         250         μps           VID Code Changing         Overvoltage to PWM going low         t <sub>CROWBAR</sub> 100         250         mv           VID Code Static         Overvoltage to PWM going low         t <sub>CROWBAR</sub> 100         500         mV           Output High Nottage         IpwMit/SOURCE) = 400 µA         V <sub>OL(PWM)</sub> 160         500         mV           Output High Nottage         IpwMit/SOURCE) = 400 µA         V <sub>OL(PWM)</sub> 4.00         5.0         V           PG Interface         Lagie High Input Voltage         IpwMit/SOURCE) = 400 µA         V <sub>OL</sub> (PWM)         4.00<   | Output Low Voltage                 | I <sub>PWRGD(SINK)</sub> = -4 mA      | V <sub>OL(PWRGD)</sub>            |      | 150  | 300  | mV   |
| VD         Odde Changing         Interface         Interface <thi< td=""><td>Power Good Delay Time</td><td></td><td></td><td></td><td></td><td></td><td></td></thi<>  | Power Good Delay Time              |                                       |                                   |      |      |      |      |
| VID Code State         Image: Combar Trip Point         Relative to DAC Output, PWRGD_Hi = 00         V <sub>CROWBAR</sub> 200         300         mV           Crowbar Adjustment Range         PWRGD_Hi Register         150         300         mV           Crowbar Reset Point         Relative to FBRTN         250         300         mV           Crowbar Day Time         Overvoltage to PWM going low         1CROWBAR         100         250         µs           VID Code Changing         100         250         0         ns         PWMGUPUS           Output By Tome         Overvoltage to PWM going low         100         250         µs           VID Code Static         100         250         µs         PWMUpUts           Output High Voltage         IpwMI(SINK) = -400 µA         VOL(pWM)         4.0         5.0         V           Output High Voltage         IpwMI(SOURCE) = 400 µA         VOL(pWM)         4.0         5.0         V           SDA Output Low Voltage         IpwMI(SOURCE) = 400 µA         VOL(pWM)         4.0         5.0         W           Logic High Input Voltage         IpwMI(SOURCE) = 400 µA         VOL(pWM)         4.0         0.8         V           Logic Low Input Voltage         IpwMI(SOURCE) = 400 µA         VOL <td>During Soft-Start</td> <td>Internal Timer</td> <td></td> <td></td> <td>2.0</td> <td></td> <td>ms</td>   | During Soft-Start                  | Internal Timer                        |                                   |      | 2.0  |      | ms   |
| Crowbar Trip Point         Relative to DAC Output, PWRGD_Hi = 00         V <sub>CROWBAR</sub> 200         300         400         mV           Crowbar Adjustment Range         PWRGD_Hi Register         150         300         300         mV           Crowbar Reset Point         Relative to FBRTN         250         300         350         mV           Crowbar Delay Time         Overvoltage to PWM going low $t_{CROWBAR}$ 100         250   | VID Code Changing                  |                                       |                                   | 100  | 250  |      | μs   |
| Crowbar Adjustment Range         PWRGD_Hi Register         150         300         mV           Crowbar Reset Point         Relative to FBRTN         250         300         350         mV           Crowbar Delay Time         Overvoltage to PWM going low         1 <sub>CROWBAR</sub> VID Code Changing         0         100         250         μs             VID Code Static         400         ns          400         ns            PWM Outputs          400         160         500         mV            Output Low Voltage         Ip <sub>WM(SINK)</sub> = -400 µA         V <sub>OL(PWM)</sub> 4.0         5.0         V           Pde Infrace           Vol.         5.0         V         V           Logic Ling Input Voltage         Ip <sub>WM(SINK)</sub> = -400 µA         V <sub>OL(PWM)</sub> 4.0         5.0         V         V           Logic Ling Input Voltage         Ip <sub>WM(SINK)</sub> = -400 µA         V <sub>OL(PWM)</sub> 4.0         5.0         mV         V           Logic Low Input Voltage         Ip <sub>MM(SINK)</sub> = -46 mA         V <sub>OL</sub> 0.4         V         V           Logic Low Input Voltage         Ip <sub>SDA</sub> =  | VID Code Static                    |                                       |                                   |      | 200  |      | ns   |
| Crowbar Adjustment Range         PWRGD_Hi Register         150         Image of the state of the                    | Crowbar Trip Point                 | Relative to DAC Output, PWRGD_Hi = 00 | V <sub>CROWBAR</sub>              | 200  | 300  | 400  | mV   |
| Crowbar Delay Time         Overvoltage to PWM going low         t <sub>CROWBAR</sub> I          | Crowbar Adjustment Range           | PWRGD_Hi Register                     |                                   | 150  |      | 300  | mV   |
| VID Code Changing         Internal         Internal <thinternal< th="">         Internal         Internal<td>Crowbar Reset Point</td><td>Relative to FBRTN</td><td></td><td>250</td><td>300</td><td>350</td><td>mV</td></thinternal<>   | Crowbar Reset Point                | Relative to FBRTN                     |                                   | 250  | 300  | 350  | mV   |
| VID Code Static         Image: Mark and the state in the state  | Crowbar Delay Time                 | Overvoltage to PWM going low          | t <sub>CROWBAR</sub>              |      |      |      |      |
| PWM Outputs         Voltput Low Voltage         IPWM(SINK) = -400 $\mu$ A         VOL(PWM)         160         500         mV           Output High Voltage         IPWM(SOURCE) = 400 $\mu$ A         VOH(PWM)         4.0         5.0         V           IPC Interface         IPWM (SOURCE) = 400 $\mu$ A         VOH(PWM)         4.0         5.0         V           Logic High Input Voltage         VIH(SDA,SCL)         2.1         V         V           Logic Low Input Voltage         VIH(SDA,SCL)         2.1         0.8         V           Hysteresis         500         mV         0.8         V           SDA Output Low Voltage         I <sub>SDA</sub> = -6 mA         VOL         0.4         V           Input Carpacitance         SSO         mV         IA         IA           Input Capacitance         SSCL, SDA         5.0         PF           Clock Frequency         fSCL         400         KHz           SCL Falling Edge to SDA Valid Time         1.0         IA         VOL         1.0         IA           Output Low Voltage         IOUT = -6 mA         VOL         0.4         V         V         Output High Leakage Current         VOH = 5.0 V         VOH         1.0         IA         V           <   | VID Code Changing                  |                                       |                                   | 100  | 250  |      | μs   |
| Output Low Voltage         IPWM(SINK) = -400 $\mu$ A         VOL(PWM)         160         500         mV           Output High Voltage         IPWM(SOURCE) = 400 $\mu$ A         VOL(PWM)         4.0         5.0         V           PC Interface         IPWM(SOURCE) = 400 $\mu$ A         VOH(PWM)         4.0         5.0         V           Logic High Input Voltage         VIH(SDA,SCL)         2.1         V         V           Logic Low Input Voltage         VIH(SDA,SCL)         2.1         0.8         V           Hystersis         Isoa         VIH(SDA,SCL)         0.0         0.8         V           SDA Output Low Voltage         Isoa         F         0.4         V         0.4         V           Input Carrent         Volt         VOL         V         0.4         V         0.4         V           Input Capacitance         Isoa         SCSCL, SDA         5.0         PF         0.0         KHz           Clock Frequency         Isoa         SCL         400         KHz         SCL Falling Edge to SDA Valid Time         VOL         0.0         KHz           Output Low Voltage         IoUT = -6 mA         VOL         VOL         0.4         V           Output Low Voltage Current   | VID Code Static                    |                                       |                                   |      | 400  |      | ns   |
| Output High Voltage         IPWM(SOURCE) = 400 $\mu$ A         V         V         4.0         5.0         V           IPC Interface           Logic High Input Voltage          VIII(SDA.SCL)         2.1          V           Logic Low Input Voltage          VIII(SDA.SCL)         2.1          V           Logic Low Input Voltage          VIII(SDA.SCL)         2.1          0.8         V           Hysteresis          VIII(SDA.SCL)          0.8         V           SDA Output Low Voltage         IsDA = -6 mA         VoL         1.0         0.4         V           Input Capacitance          S.0 $pF$ Clock Frequency         5.0 $pF$ Clock Frequency           MO $kIz$ SCL Falling Edge to SDA Valid Time         1.0 $\mu$ A           ALEERT, FAULT Outputs           MO $kIz$ MO $kIz$ Output Low Voltage         IoUT = -6 mA         VoL $kI$ $kIz$ $kIz$ TSENSE Inputs          T         TSENSE Inputs $kIz$ $kIz$   | PWM Outputs                        |                                       |                                   |      | -    |      |      |
| Output High Voltage         IPWM(SOURCE) = 400 $\mu$ A         V         V         4.0         5.0         V           IPC Interface           Logic High Input Voltage          VIII(SDA.SCL)         2.1          V           Logic Low Input Voltage          VIII(SDA.SCL)         2.1          V           Logic Low Input Voltage          VIII(SDA.SCL)         2.1          0.8         V           Hysteresis          VIII(SDA.SCL)          0.8         V           SDA Output Low Voltage         IsDA = -6 mA         VoL         1.0         0.4         V           Input Capacitance          S.0 $pF$ Clock Frequency         5.0 $pF$ Clock Frequency           MO $kIz$ SCL Falling Edge to SDA Valid Time         1.0 $\mu$ A           ALEERT, FAULT Outputs           MO $kIz$ MO $kIz$ Output Low Voltage         IoUT = -6 mA         VoL $kI$ $kIz$ $kIz$ TSENSE Inputs          T         TSENSE Inputs $kIz$ $kIz$   | Output Low Voltage                 | $I_{PWM(SINK)} = -400 \ \mu A$        | V <sub>OL(PWM)</sub>              |      | 160  | 500  | mV   |
| IPC InterfaceLogic High Input VoltageImage Amplity Set  | Output High Voltage                |                                       |                                   | 4.0  | 5.0  |      | V    |
| Logic Low Input VoltageVIH(SDA,SCL)00.8VHysteresis1500mVSDA Output Low Voltage $I_{SDA} = -6 \text{ mA}$ $V_{OL}$ 0.4VInput CurrentVIH(SDA,SCL)-11.0 $\mu A$ Input Capacitance $C_{SCL,SDA}$ 5.0 $pF$ Clock Frequency $f_{SCL}$ 400kHzSCL Falling Edge to SDA Valid Time1.0 $\mu S$ ALERT, FAULT Outputs1.0 $\mu S$ Output Low Voltage $I_{OUT} = -6 \text{ mA}$ $V_{OL}$ 0.4VOutput Low Voltage $I_{OUT} = -6 \text{ mA}$ $V_{OL}$ 0.4VOutput Low Voltage $I_{OUT} = -6 \text{ mA}$ $V_{OL}$ 0.4VOutput Low Voltage $I_{OUT} = -6 \text{ mA}$ $V_{OL}$ 0.4VOutput High Leakage Current $V_{OH} = 5.0 \text{ V}$ $V_{OH}$ 1.0 $\mu A$ TTSENSE InputsTTSENSE Voltage RangeInternally Limited03.0VSource Current $R_{IREF} = 121 \text{ k}\Omega$ $I_{TH}$ -110-125-140 $\mu A$ VRHOT Output Low Voltage $I_{VRHOT(SINK)} = -4 \text{mA}$ 02.0VADC ResolutionLSB Weighting02.0VADC ResolutionLSB Weighting02.0VADC ResolutionChapter Hange02.0VADC ResolutionSDC Input Voltage Range01.95mVADC ResolutionSDC Resolution1.95mV   | I <sup>2</sup> C Interface         |                                       |                                   |      |      |      |      |
| Logic Low Input Voltage         Image of the system o | Logic High Input Voltage           |                                       | VIH(SDA,SCL)                      | 2.1  |      |      | V    |
| Hysteresis         Image: model of the system of the  | Logic Low Input Voltage            |                                       |                                   |      |      | 0.8  | V    |
| $\begin{tabular}{ c c c c c c c } \hline Input Current & V_{IH}, I_{IL} & -1 & 1.0 & \mu A \\ \hline Input Capacitance & C_{SCL, SDA} & 5.0 & pF \\ \hline Clock Frequency & f_{SCL} & 400 & kHz \\ \hline SCL Falling Edge to SDA Valid Time & & & & & & & & & & & & & & & & & & &$  | Hysteresis                         |                                       |                                   |      | 500  |      | mV   |
| Input CapacitanceCSCL, SDA5.0 $\rho F$ Clock FrequencyfSCLfSCL400kHzSCL Falling Edge to SDA Valid Time1.0 $\mu s$ ALERT, FAULT OutputsOutput Low Voltage $I_{OUT} = -6 \text{ mA}$ $V_{OL}$ 1.0 $0.4$ $V$ Output High Leakage Current $V_{OH} = 5.0 \text{ V}$ $V_{OH}$ 1.0 $\mu A$ TTSENSE InputsTTSENSE Voltage RangeInternally Limited03.0 $V$ Source Current $R_{IREF} = 121 \text{ k}\Omega$ $I_{TH}$ $-110$ $-125$ $-140$ $\mu A$ VRHOT Output Low Voltage $I_{VRHOT(SINK)} = -4mA$ 01.50300mVInput Voltage Conversion RangeLSB Weighting02.0 $V$ $ADC$ Resolution2.0 $V$ ADC Input Voltage RangeIncernality Limited02.0 $V$ $ADC$ Resolution1.95 $M$   | SDA Output Low Voltage             | I <sub>SDA</sub> = -6 mA              | V <sub>OL</sub>                   |      |      | 0.4  | V    |
| Clock FrequencyImage: clock Frequency400kHzSCL Falling Edge to SDA Valid TimeImage: clock FrequencyfSCLImage: clock Frequency400kHzSCL Falling Edge to SDA Valid TimeImage: clock FrequencyImage: cloc  | Input Current                      |                                       | V <sub>IH</sub> ; I <sub>IL</sub> | -1   |      | 1.0  | μA   |
| SCL Falling Edge to SDA Valid Time1.0 $\mu$ sALERT, FAULT OutputsOutput Low Voltage $I_{OUT} = -6 \text{ mA}$ $V_{OL}$ 0.4VOutput High Leakage Current $V_{OH} = 5.0 \text{ V}$ $V_{OH}$ 1.0 $\mu$ ATTSENSE InputsTTSENSE Voltage RangeInternally Limited03.0VSource Current $R_{IREF} = 121 \text{ k}\Omega$ $I_{TH}$ -110-125-140 $\mu$ AVRHOT Output Low Voltage $V_{VHOT(SINK)} = -4mA$ 0150300mVInput Voltage Conversion Range02.0VVADC ResolutionLSB Weighting02.0VADC Input Voltage Range02.0VADC Resolution1.95mV   | Input Capacitance                  |                                       | C <sub>SCL, SDA</sub>             |      | 5.0  |      | pF   |
| ALERT, FAULT OutputsOutput Low Voltage $I_{OUT} = -6 \text{ mA}$ $V_{OL}$ 0.4VOutput High Leakage Current $V_{OH} = 5.0 \text{ V}$ $V_{OH}$ 1.0 $\mu A$ TTSENSE InputsTTSENSE Voltage RangeInternally Limited03.0VSource Current $R_{IREF} = 121 \text{ k}\Omega$ $I_{TH}$ -110-125-140 $\mu A$ VRHOT Output Low Voltage $V_{VRHOT(SINK)} = -4mA$ 0150300mVInput Voltage Conversion Range02.0VADC ResolutionLSB Weighting02.0VADC Input Voltage Range02.0VADC Resolution1.95mV  | Clock Frequency                    |                                       | f <sub>SCL</sub>                  |      |      | 400  | kHz  |
| Output Low Voltage $I_{OUT} = -6 \text{ mA}$ $V_{OL}$ V00.4VOutput High Leakage Current $V_{OH} = 5.0 \text{ V}$ $V_{OH}$ V1.0 $\mu$ ATTSENSE InputsTTSENSE Voltage RangeInternally Limited03.0VSource Current $R_{IREF} = 121 \text{ k}\Omega$ $I_{TH}$ -110-125-140 $\mu$ AVRHOT Output Low Voltage $V_{RHOT(SINK)} = -4mA$ 0150300mVInput Voltage Conversion RangeLSB Weighting02.0VADC ResolutionLSB Weighting02.0VADC Input Voltage Range02.0VADC ResolutionInput Voltage Range01.95mV   | SCL Falling Edge to SDA Valid Time |                                       |                                   |      |      | 1.0  | μs   |
| Output High Leakage Current $V_{OH} = 5.0 \text{ V}$ $V_{OH}$ Image: Marcine Current $I.0$ $\mu A$ TTSENSE Inputs         Internally Limited         0         3.0 $V$ Source Current         RIREF = 121 k $\Omega$ $I_{TH}$ -110         -125         -140 $\mu A$ VRHOT Output Low Voltage $V_{RHOT(SINK)} = -4mA$ Image: Marcine Conversion Range         0         2.0         V           ADC Resolution         LSB Weighting         LSB Weighting         0         2.0         V           ADC Input Voltage Range         Image: Marcine Converter         O         2.0         V           ADC Resolution         Instance         0         1.95         M  | ALERT, FAULT Outputs               |                                       |                                   |      |      |      |      |
| Output High Leakage Current $V_{OH} = 5.0 \text{ V}$ $V_{OH}$ Image: Marcine Current $I.0$ $\mu A$ TTSENSE Inputs         Internally Limited         0         3.0 $V$ Source Current         RIREF = 121 k $\Omega$ $I_{TH}$ -110         -125         -140 $\mu A$ VRHOT Output Low Voltage $V_{RHOT(SINK)} = -4mA$ Image: Marcine Conversion Range         0         2.0         V           ADC Resolution         LSB Weighting         LSB Weighting         0         2.0         V           ADC Input Voltage Range         Image: Marcine Converter         O         2.0         V           ADC Resolution         Instance         0         1.95         M  | Output Low Voltage                 | I <sub>OUT</sub> = -6 mA              | V <sub>OL</sub>                   |      |      | 0.4  | V    |
| TTSENSE Voltage RangeInternally Limited03.0VSource Current $R_{IREF} = 121 k\Omega$ $I_{TH}$ $-110$ $-125$ $-140$ $\mu$ AVRHOT Output Low Voltage $I_{VRHOT(SINK)} = -4mA$ 150300mVInput Voltage Conversion Range02.0VADC ResolutionLSB Weighting2.0mVAnalog / Digital Converter02.0VADC Input Voltage Range02.0VADC Resolution1.95mV   | Output High Leakage Current        | V <sub>OH</sub> = 5.0 V               | V <sub>OH</sub>                   |      |      | 1.0  | μA   |
| Source Current $R_{IREF} = 121 k\Omega$ $I_{TH}$ $-110$ $-125$ $-140$ $\mu A$ VRHOT Output Low Voltage $I_{VRHOT(SINK)} = -4mA$ 150300mVInput Voltage Conversion Range002.0VADC ResolutionLSB Weighting02.0mVAnalog / Digital ConverterADC Input Voltage Range02.0VADC Resolution1.95mV01.95  | TTSENSE Inputs                     |                                       |                                   |      |      |      |      |
| VRHOT Output Low Voltage         IVRHOT(SINK) = -4mA         Intel  | TTSENSE Voltage Range              | Internally Limited                    |                                   | 0    |      | 3.0  | V    |
| Input Voltage Conversion Range02.0VADC ResolutionLSB Weighting2.0mVAnalog / Digital ConverterADC Input Voltage Range02.0VADC Resolution02.0VADC Resolution01.95mV   | Source Current                     | R <sub>IREF</sub> = 121 kΩ            | I <sub>TH</sub>                   | -110 | -125 | -140 | μA   |
| Input Voltage Conversion Range02.0VADC ResolutionLSB Weighting2.0mVAnalog / Digital ConverterADC Input Voltage Range02.0VADC Resolution02.0VADC Resolution01.95mV   | VRHOT Output Low Voltage           | I <sub>VRHOT(SINK)</sub> = -4mA       |                                   |      | 150  | 300  | mV   |
| Analog / Digital Converter         ADC Input Voltage Range       0       2.0       V         ADC Resolution       1.95       mV   | Input Voltage Conversion Range     |                                       |                                   | 0    |      | 2.0  | V    |
| ADC Input Voltage Range     0     2.0     V       ADC Resolution     1.95     mV  | ADC Resolution                     | LSB Weighting                         |                                   |      | 2.0  |      | mV   |
| ADC Resolution 1.95 mV  | Analog / Digital Converter         |                                       |                                   |      |      |      |      |
|   | ADC Input Voltage Range            |                                       |                                   | 0    |      | 2.0  | V    |
| Total Linadiusted Error (TLIE)  | ADC Resolution                     |                                       |                                   |      | 1.95 |      | mV   |
|   | Total Unadjusted Error (TUE)       |                                       |                                   |      | 1.0  |      | %    |
| Differential Non–linearity (DNL) 8 Bits 1.0 LSB   | Differential Non-linearity (DNL)   | 8 Bits                                |                                   |      | 1.0  |      | LSB  |

Refer to Absolute Maximum Ratings and Application Information for Safe Operating Area.
 Guaranteed by design, not production tested.

#### **ELECTRICAL CHARACTERISTICS**

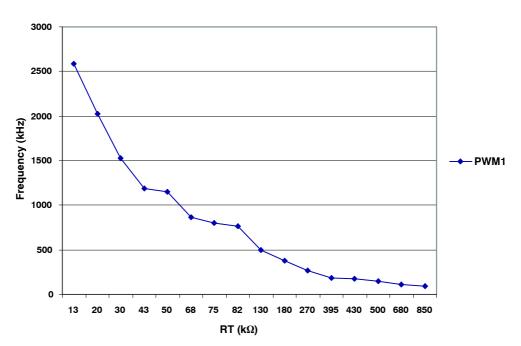
 $V_{IN} = (5.0 \text{ V}) \text{ FBRTN} - \text{GND}$ , for typical values  $T_A = 25^{\circ}\text{C}$ , for min/max values  $T_A = 0^{\circ}\text{C}$  to  $85^{\circ}\text{C}$ ; unless otherwise noted. (Notes 1 and 2)

| Parameter                        | Test Conditions   | Symbol           | Min  | Тур  | Max   | Unit |
|----------------------------------|---|------------------|------|------|-------|------|
| Analog / Digital Converter cont. | Analog / Digital Converter <i>cont.</i>                         |                  |      |      |       |      |
| Conversion Time, Voltage Channel | Averaging Enabled (32 averages)                                 |                  |      | 80   |       | ms   |
| Round Robin Cycle Time           |   |                  |      | TBD  |       | ms   |
| ADD Input                        |   |                  |      |      |       |      |
| ADD Output Current               | $I_{ADD} = 2/3*I_{IREF}$  | I <sub>ADD</sub> |      | 10   |       | μA   |
| Address 000 Threshold            |   |                  |      |      | 0.1   | V    |
| Address 001 Threshold            |   |                  | 0.15 |      | 0.225 | V    |
| Address 010 Threshold            |   |                  | 0.3  |      | 0.45  | V    |
| Address 011 Threshold            |   |                  | 0.5  |      | 0.675 | V    |
| Address 100 Threshold            |   |                  | 0.75 |      | 0.9   | V    |
| Address 101 Threshold            |   |                  | 1.0  |      | 1.25  | V    |
| Address 110 Threshold            |   |                  | 1.35 |      | 1.7   | V    |
| Address 111 Threshold            |   |                  | 1.8  |      |       | V    |
| Supply                           |   |                  |      |      |       |      |
| V <sub>CC</sub>                  | V <sub>CC</sub>   |                  | 4.7  | 5.25 | 5.75  | V    |
| DC Supply Current (see Figure 2) | $V_{\text{SYSTEM}}$ = 13.2 V, $R_{\text{SHUNT}}$ = 340 $\Omega$ | I <sub>VCC</sub> |      | 20   | 25    | mA   |
|                                  |   |                  |      |      |       |      |

| DC Supply Current (see Figure 2) | $V_{SYSTEM}$ = 13.2 V, $R_{SHUNT}$ = 340 $\Omega$ | I <sub>VCC</sub>  |     | 20  | 25  | mA |
|----------------------------------|---|-------------------|-----|-----|-----|----|
| UVLO Turn-On Current             |   |                   |     | 6.5 | 11  | mA |
| UVLO Threshold Voltage           | V <sub>CC</sub> Rising                            | V <sub>UVLO</sub> | 9.5 |     |     | V  |
| UVLO Turn-Off Voltage            | V <sub>CC</sub> Falling                           |                   |     | 4.1 |     | V  |
| VCC3 Output Voltage              | I <sub>VCC3</sub> = 1 mA                          | VCC3              | 3.0 | 3.3 | 3.6 | V  |

1. Refer to Absolute Maximum Ratings and Application Information for Safe Operating Area.

2. Guaranteed by design, not production tested.



## **TYPICAL CHARACTERISTICS**



## **TEST CIRCUITS**

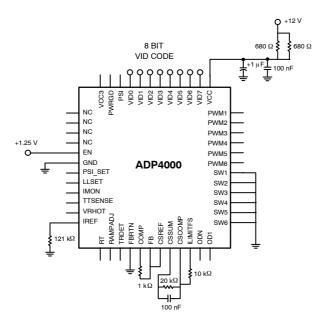
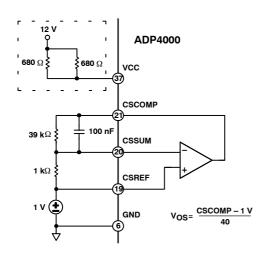
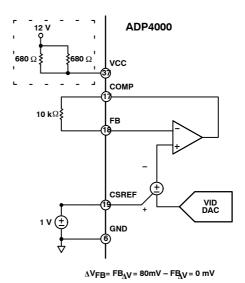


Figure 4. Closed-Loop Output Voltage Accuracy









#### Description

The ADP4000 is a 6–Phase VR11.1 regulator with an I<sup>2</sup>C Interface Typical application circuits is shown in Figure 2.

#### Startup Sequence

The ADP4000 follows the VR11 startup sequence shown in Figure 7. After both the EN and UVLO conditions are met, a programmable internal timer goes through one delay cycle TD1. This delay cycle is programmed using Delay Command, default delay = 2 ms, see Table 1 for programmable values). The first six clock cycles of TD2 are blanked from the PWM outputs and used for phase detection as explained in the following section. Then the programmable internal soft-start ramp is enabled (TD2) and the output comes up to the boot voltage of 1.1 V. The boot hold time is also set by Delay Command. This second delay cycle is called TD3. During TD3 the processor VID pins settle to the required VID code. When TD3 is over, the ADP4000 reads the VID inputs and soft-starts either up or down to the final VID voltage (TD4). After TD4 has been completed and the PWRGD masking time (equal to VID on the fly masking) is finished, a third cycle of the internal timer sets the PWRGD blanking (TD5).

The internal delay and soft-start times are programmable using the serial interface and the Delay Command and the Soft-Start Commands.

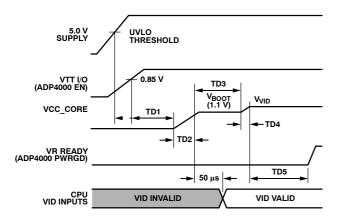


Figure 7. System Startup Sequence for VR11

#### **Internal Delay Timer**

An internal timer sets the delay times for the startup sequence, TD1, TD3 and TD5. The default time is 2msec, which can be changed using the  $I^2C$  interface. This timer is used for multiple delay timings (TD1, TD3 and TD5) during the startup sequence. Also, it is used for timing the current limit latchoff as explained in the Current Limit section. The current limit timer is set to 4 times the delay timer.

#### Table 1. Delay Codes

| Code | Delay (msec) |
|------|--------------|
| 000  | 0.5          |
| 001  | 1            |
| 010  | 1.5          |
| 011  | 2 = default  |
| 100  | 2.5          |
| 101  | 3            |
| 110  | 3.5          |
| 111  | 4            |

The delay timer is programmed using Bits <2:0> of the Ton Delay command (0xD4). The delay can be programmed between 0.5 msec and 4 msec. Table 1 provides the programmable delay times.

### Soft-Start

The soft-start slope for the output voltage is set by an internal timer. The default value is 0.5 V/msec, which can be programmed through the I<sup>2</sup>C interface. After TD1 and the phase detection cycle have been completed, the SS time (TD2 in Figure 7) starts. The SS circuit uses the internal VID DAC to increase the output voltage in 6.25 mV steps up to the 1.1 V boot voltage.

Once the SS circuit has reached the boot voltage, the boot voltage delay time (TD3) is started. The end of the boot voltage delay time signals the beginning of the second soft–start time (TD4). The SS voltage changes from the boot voltage to the programmed VID DAC voltage (either higher or lower) using 6.25 mV steps.

The soft-start slew rate is programmed using Bits <2:0> of the Ton\_Rise (0xD5) command code. Table 2 provides the soft-start values.

| Code | Slew Rate (V/msec) |
|------|--------------------|
| 000  | 0.1                |
| 001  | 0.3                |
| 010  | 0.5 = default      |
| 011  | 0.7                |
| 100  | 0.9                |
| 101  | 1.1                |
| 110  | 1.3                |
| 111  | 1.5                |

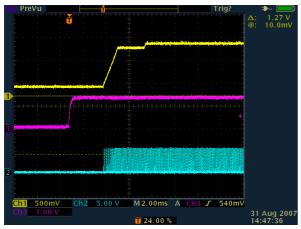


Figure 8. System Startup Sequence for VR11

Figure 8 shows typical startup waveforms for the ADP4000.

Figure 8. Typical Startup Waveforms Channel 1: CSREF (yellow) Channel 2: PWM1 (blue) Channel 3 : Enable (pink)

#### **Phase Detection**

During startup, the number of operational phases and their phase relationship is determined by the internal circuitry that monitors the PWM outputs. Normally, the ADP4000 operates as a 6-phase PWM controller.

To operate as a 5-Phase Controller connect PWM6 to V<sub>CC</sub>.

To operate as a 4–Phase Controller connect PWM5 and PWM6 to  $V_{CC}\!.$ 

To operate as a 3–Phase Controller connect PWM4, PWM5 and PWM6 to  $V_{CC}\!.$ 

To operate as a 2–Phase Controller connect PWM3, PWM4, PWM5 and PWM6 to  $V_{CC}. \label{eq:VCC}$ 

To operate as a single-phase controller connect PMW2, PWM3, PWM4, PWM5 and PWM6 to  $V_{CC}$ .

Prior to soft-start, while EN is high the PWM6, PWM5, PWM4 PWM3 and PWM2 pins sink approximately 100  $\mu$ A each. An internal comparator checks each pin's voltage vs. a threshold of 3.0 V. If the pin is tied to V<sub>CC</sub>, it is above the threshold. Otherwise, an internal current sink pulls the pin to GND, which is below the threshold. PWM1 is low during the phase detection interval that occurs during the first six clock cycles of TD2. After this time, if the remaining PWM outputs are not pulled to V<sub>CC</sub>, the 100  $\mu$ A current sink is removed, and they function as normal PWM outputs. If they are pulled to V<sub>CC</sub>, the 100  $\mu$ A current source is removed, and the outputs are put into a high impedance state.

The PWM outputs are logic-level devices intended for driving fast response external gate drivers such as the ADP3121. Because each phase is monitored independently, operation approaching 100% duty cycle is possible. In addition, more than one output can be on at the same time to allow overlapping phases.

#### **Master Clock Frequency**

The clock frequency of the ADP4000 is set with an external resistor connected from the RT pin to ground. The frequency follows the graph in Figure 3. To determine the frequency per phase, the clock is divided by the number of phases in use. If all phases are in use, divide by 6. If 4 phases are in use then divide by 4.

$$R_{T} = \frac{1}{n \times f_{SW} \times Cr} - R_{TO} \qquad (eq. 1)$$

where CT = 2.2 pF and RTO = 21 k

#### **Output Voltage Differential Sensing**

The ADP4000 combines differential sensing with a high accuracy VID DAC and reference, and a low offset error amplifier. This maintains a worst-case specification of  $\pm 7$  mV differential sensing error over its full operating output voltage and temperature range. The output voltage is sensed between the FB pin and FBRTN pin. FB is connected through a resistor, R<sub>B</sub>, to the regulation point, usually the remote sense pin of the microprocessor. FBRTN is connected directly to the remote sense ground point. The internal VID DAC and precision reference are referenced to FBRTN, which has a minimal current of 100  $\mu$ A to allow accurate remote sensing. The internal error amplifier compares the output of the DAC to the FB pin to regulate the output voltage.

#### Output Current Sensing

The ADP4000 provides a dedicated current-sense amplifier (CSA) to monitor the total output current for proper voltage positioning vs. load current, for the IMON output and for current-limit detection. Sensing the load current at the output gives the total real time current being delivered to the load, which is an inherently more accurate method than peak current detection or sampling the current across a sense element such as the low-side MOSFET. This amplifier can be configured several ways, depending on the objectives of the system, as follows:

- Output inductor DCR sensing without a thermistor for lowest cost.
- Output inductor DCR sensing with a thermistor for improved accuracy with tracking of inductor temperature.
- Sense resistors for highest accuracy measurements.

The positive input of the CSA is connected to the CSREF pin, which is connected to the average output voltage. The inputs to the amplifier are summed together through resistors from the sensing element, such as the switch node side of the output inductors, to the inverting input CSSUM. The feedback resistor between CSCOMP and CSSUM sets the gain of the amplifier and a filter capacitor is placed in parallel with this resistor. The gain of the amplifier is programmable by adjusting the feedback resistor. This difference signal is used internally to offset the VID DAC for voltage positioning. This difference signal can be adjusted between 50% and 150% of the external value

using the I<sup>2</sup>C Loadline Calibration (0xDE) and Loadline Set (0xDF) commands.

The difference between CSREF and CSCOMP is used as a differential input for the current-limit comparator.

To provide the best accuracy for sensing current, the CSA is designed to have a low offset input voltage. Also, the sensing gain is determined by external resistors to make it extremely accurate.

The CPU current can also be monitored over the  $I^2C$  interface. The current limit and the load line can be adjusted from the circuit component values over the  $I^2C$  interface.

#### **Current Limit Setpoint**

The current limit threshold on the ADP4000 is programmed by a resistor between the ILIMFS pin and the CSCOMP pin. The ILIMFS current,  $I_{ILIMFS}$ , is compared with an internal current reference of 22  $\mu$ A. If  $I_{ILIMFS}$ exceeds 22  $\mu$ A then the output current has exceeded the limit and the current limit protection is tripped.

$$I_{ILIMFS} = \frac{V_{ILIMFS} - V_{CSCOMP}}{R_{ILIMFS}}$$
 (eq. 2)

$$V_{\text{CSREF}} - V_{\text{CSCOMP}} = \frac{\text{R}_{\text{CS}}}{\text{R}_{\text{PH}}} \times \text{R}_{\text{L}} \times \text{I}_{\text{LOAD}} \quad \text{(eq. 3)}$$

Where  $R_L = DCR$  of the Inductor.

Assuming that

$$\frac{R_{CS}}{R_{PH}} \times R_L = 1 \text{ m}\Omega \tag{eq. 4}$$

i.e. the external circuit is set up for a  $1m\Omega$  Loadline then the  $R_{ILIMFS}$  is calculated as follows

$$I_{\text{ILIMFS}} = \frac{1 \text{ m}\Omega \times I_{\text{LOAD}}}{R_{\text{ILIMITES}}}$$
(eq. 5)

Assuming we want a current limit of 150A that means that  $I_{LIMFS}$  must equal 22  $\mu$ A at that load.

$$20 \ \mu A = \frac{1 \ m\Omega \times 150 \ AD}{R_{\text{ILIMITFS}}} = 6.8 \ k\Omega \qquad (\text{eq. 6})$$

Solving this equation for  $R_{LIMITFS}$  we get 6.8 k $\Omega$ . The closest 1% resistor value is 6.8 k $\Omega$ .

The current limit threshold can be modified from the resistor programmed value by using the  $I^2C$  interface using Bits <4:0> of the Current Limit Threshold command (0xE2). The limit is programmable between 50% of the external limit and 146.7% of the external limit. The resolution is 3.3%. Table 3 gives some examples codes.

#### Table 3. Current Limit

| Code   | Current Limit (% of external limit) |
|--------|-------------------------------------|
| 0 0000 | 50%                                 |
| 0 0001 | 53.3%                               |
| 1 0000 | 100% = default                      |
| 1 0001 | 103.3%                              |
| 1 1110 | 143.3%                              |
| 1 1111 | 146.7%                              |

#### Current Limit, Short-Circuit and Latchoff protection

If the current limit is reached and TD5 has completed the controller will start to latchoff. If there is a current limit during startup, the ADP4000 will go through TD1 to TD5, and then start the latchoff. Because the controller continues to cycle the phases during the latchoff, if the short is removed before the timer is complete, the controller can return to normal operation.

The latchoff function can be reset by either removing and reapplying the supply voltage to the ADP4000, or by toggling the EN pin low for a short time.

During startup when the output voltage is below 200 mV, a secondary current limit is active. This is necessary because the voltage swing of CSCOMP cannot go below ground. This secondary current limit limits the internal COMP voltage to the PWM comparators to 1.5 V. This limits the voltage drop across the low-side MOSFETs through the current balance circuitry. Typical over-current latchoff waveforms are shown in Figure 9.

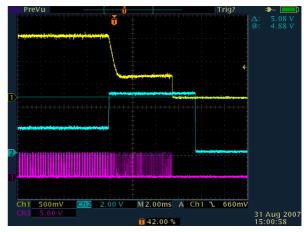


Figure 9. Overcurrent Latchoff Waveforms Channel 1: CSREF, Channel 2: COMP, Channel 3: PWM1

An inherent per phase current limit protects individual phases if one or more phases stops functioning because of a faulty component. This limit is based on the maximum normal mode COMP voltage.

#### **Output Current Monitor**

 $I_{MON}$  is an analog output from the ADP4000 representing the total current being delivered to the load. It outputs an accurate current that is directly proportional to the current set by the ILIMFS resistor.

$$I_{\rm IMON} = 10 \times I_{\rm ILIMFS}$$
 (eq. 7)

The current is then run through a parallel RC connected from the  $I_{MON}$  pin to the FBRTN pin to generate an accurately scaled and filtered voltage as per the VR11.1 specification. The size of the resistor is used to set the  $I_{MON}$  scaling.

The scaling is set such that  $I_{MON} = 900 \text{mV}$  at the TDC current of the processor. This means that the  $R_{IMON}$  resistor should be chosen as follows.

From the Current Limit Setpoint paragraph we know the following:

$$I_{ILIMFS} = \frac{1 \text{ m}\Omega \times I_{LOAD}}{R_{ILIMFS}} \tag{eq. 8}$$

$$I_{IMON} = 10 \times \frac{1 \text{ m}\Omega \times I_{LOAD}}{R_{ILIMFS}} \tag{eq. 9}$$

For a 150 A current limit  $R_{LIMFS} = 7.5 \text{ k}\Omega$ . Assuming the TDC = 135 A then  $V_{MON}$  should equal 900 mV when  $I_{LOAD} = 135$  A.

When  $I_{LOAD} = 135A$ ,  $I_{MON}$  equals

$$I_{IMON} \,=\, 10\,\times\,\frac{1\,m\Omega\,\times\,135\,A}{6.81\,k\Omega} \,=\, 198\,\,\mu A \eqno(eq.\,10)$$

 $V_{IMON} = 900 \text{ mV} = 198 \ \mu\text{A} \times \text{R}_{MON} \qquad (\text{eq. 11})$ 

This gives a value of 4.54 k $\Omega$  for R<sub>MON</sub>.

If the TDC and OCP limit for the processor have to be changed then it may be necessary to change the ILIMITFS resistor only. This is because the ILIMITFS resistor sets up both the current limit and also the current out of the  $I_{MON}$  pin, as explained earlier.

The  $I_{MON}$  pin also includes an active clamp to limit the  $I_{MON}$  voltage to 1.15 V MAX while maintaining accuracy at 900 mV full scale.

#### Active Impedance Control Mode

For controlling the dynamic output voltage droop as a function of output current, the CSA gain and load line programming can be scaled to be equal to the droop impedance of the regulator times the output current. This droop voltage is then used to set the input control voltage to the system. The droop voltage is subtracted from the DAC reference input voltage directly to tell the error amplifier where the output voltage should be. This allows enhanced feed-forward response.

#### Load Line Setting

The Loadline is programmable over the  $I^2C$  interface on the ADP4000. It is programmed using the Loadline Calibration (0xDE) and Loadline Set (0xDF) commands. The loadline can be adjusted between 0% and 100% of the external R<sub>CSA</sub>. In this example R<sub>CSA</sub> = 1 m $\Omega$ . R<sub>O</sub> needs to 0.8 m $\Omega$ . Therefore programming the Loadline Calibration + Loadline Set Register to give a combined percentage of 80% will set the R<sub>O</sub> to 0.8 m $\Omega$ .

| Code   | Loadline (as a percentage of R <sub>CSA</sub> ) |
|--------|---|
| 0 0000 | 0%  |
| 0 0001 | 3.3%  |
| 1 0000 | 50% = default                                   |
| 1 0001 | 53.3%   |
| 1 1110 | 96.7%   |
| 1 1111 | 100%  |

#### **Current Control Mode and Thermal Balance**

The ADP4000 has individual inputs (SW1 to SW6) for each phase that are used for monitoring the current of each phase. This information is combined with an internal ramp to create a current balancing feedback system that has been optimized for initial current balance accuracy and dynamic thermal balancing during operation. This current balance information is independent of the average output current information used for positioning as described in the section.

The magnitude of the internal ramp can be set to optimize the transient response of the system. It also monitors the supply voltage for feed-forward control for changes in the supply. A resistor connected from the power input voltage to the RAMPADJ pin determines the slope of the internal PWM ramp.

The balance between the phases can be programmed using the I<sup>2</sup>C Phase Bal SW(x) commands (0xE3 to 0xE8). This allows each phase to be adjusted if there is a difference in temperature due to layout and airflow considerations. The phase balance can be adjusted from a default gain of 5 (Bits 4:0 = 10000). The minimum gain programmable is 3.75 (Bits 4:0 = 00000) and the max gain is 6.25 (Bits 4:0 = 11111).

#### **Voltage Control Mode**

A high gain, high bandwidth, voltage mode error amplifier is used for the voltage mode control loop. The control input voltage to the positive input is set via the VID logic according to the voltages listed in VID Code Table. The VID code is set using the VID Input pins or it can be programmed over the  $I^2C$  interface using the V<sub>OUT</sub>\_Command. By default, the ADP4000 outputs a voltage corresponding to the VID Inputs. To output a voltage following the V<sub>OUT</sub>\_Command the user first needs to program the required VID Code. Then the VID\_EN Bits need to be enabled. The following is the sequence:

- 1. Program the required VID Code to the
  - V<sub>OUT</sub>\_Command code (0x21)
- 2. Set the VID\_EN bit (Bit 3) in the VR Config 1 A (0xD2) and on the VR Config 1B (0xD3).

This voltage is also offset by the droop voltage for active positioning of the output voltage as a function of current, commonly known as active voltage positioning. The output of the amplifier is the COMP pin, which sets the termination voltage for the internal PWM ramps.

The negative input (FB) is tied to the output sense location with Resistor  $R_B$  and is used for sensing and controlling the output voltage at this point. A current source (equal to  $I_{FB}$ ) from the FB pin flowing through  $R_B$  is used for setting the no load offset voltage from the VID voltage. The no load voltage is negative with respect to the VID DAC for Intel CPU's.

The value of  $R_{\rm B}$  can be found using the following equation:

$$R_{B} = \frac{V_{VID} - V_{ONL}}{I_{IFB}}$$
 (eq. 12)

An offset voltage can be added to the control voltage over the serial interface. This is done using Bits <5:0> of the  $V_{OUT}$ \_TRIM (0xDB) and  $V_{OUT}$ \_CAL (0xDC) Commands. The max offset that can be applied is ±193.75 mV (even if the sum of the offsets > 193.75mV). The LSB size is 6.25 mV. A positive offset is applied when Bit 5 = 0. A negative offset is applied when Bit 5 = 1.

Table 5. Offset Codes

| VOUT_<br>TRIM<br>CODE | TRIM<br>OFFSET<br>VOLTAGE | VOUT_<br>CAL<br>CODE | CAL<br>OFFSET<br>VOLTAGE | TOTAL<br>OFFSET<br>VOLTAGE |
|-----------------------|---------------------------|----------------------|--------------------------|----------------------------|
| 00 1000               | 50 mV                     | 00<br>0010           | 12.5 mV                  | 62.5 mV                    |
| 10 0001               | -6.25 mV                  | 10 1110              | -87.5 mV                 | -93.75 mV                  |
| 00 1111               | 93.75 mV                  | 10<br>0001           | -6.25 mV                 | 87.5 mV                    |

#### **RAMPADJ Input Current**

The resistor connected to the Rampadj pin sets the internal PWM ramp. The value for this resistor is chosen to provide the combination of thermal balance, stability and transient response.

$$\mathsf{R}_\mathsf{R} = \frac{\mathsf{A}_\mathsf{R} \times \mathsf{L}}{3 \times \mathsf{A}_\mathsf{D} \times \mathsf{R}_\mathsf{DS} \times \mathsf{C}_\mathsf{R}} \tag{eq. 13}$$

Where

 $A_R$  is the internal ramp amplifier gain (= 0.5)

 $A_D$  is the current balancing amplifier gain (= 5)

 $R_{DS}$  is the total low side MOSFET on resistance

 $C_R$  is the internal ramp capacitor value (= 5pF). The internal ramp voltage can be calculated as follows:

$$V_{R} = \frac{A_{R} \times (1 - D) \times V_{VID}}{R_{R} \times C_{R} \times f_{SW}} \qquad (\text{eq. 14})$$

The size of the internal ramp can be made larger or smaller. If it is made larger, stability and noise rejection improves but the transient performance decreases. If the ramp is made smaller then the transient response improves however noise rejection and stability degrades.

#### COMP Pin Ramp

There is a ramp signal on the COMP signal, which is due to the droop voltage and the output voltage ramps. This ramp adds to the internal ramp to produce the following ramp signal at the PWM input.

$$V_{\text{RT}} = \frac{V_{\text{R}}}{\left(1 - \frac{2 \times (1 - n \times D)}{n \times f_{\text{SW}} \times C_{\text{X}} \times R_{\text{O}}}\right)} \quad (\text{eq. 15})$$

Where Cx = bulk capacitance

 $R_O = Droop$ n = number of phases

 $f_{SW}$  = switching frequency per phase

D = duty cycle

 $V_R$  = Internal Ramp Voltage (calculated in Rampadj section of this data sheet)

This ramp voltage should be set to at least 0.5 V for noise immunity reasons. If it is less than 0.5 V then decrease the ramp resistor.

#### Dynamic VID

The ADP4000 has the ability to respond to dynamically changing VID inputs while the controller is running. This allows the output voltage to change while the supply is running and supplying current to the load. This is commonly referred to as Dynamic VID (DVID). A DVID can occur under either light or heavy load conditions. The processor signals the controller by changing the VID inputs (or by programming a new  $V_{OUT}$ \_Command) in a single or multiple steps from the start code to the finish code. This change can be positive or negative.

When a VID bit changes state, the ADP4000 detects the change and ignores the DAC inputs for a minimum of 200 ns. This time prevents a false code due to logic skew while the VID inputs are changing. Additionally, the first VID change initiates the PWRGD and CROWBAR blanking functions for a minimum of 100  $\mu$ s to prevent a false PWRGD or CROWBAR event. Each VID change resets the internal timer.

If a VID off code is detected the ADP4000 will wait for 5  $\mu$ sec to ensure that the code is correct before initiating a shutdown of the controller.

The ADP4000 also uses the TON\_Transition command code (0xD6) to limit the DVID slew rates. These can be encountered when the system does a large single VID step for power state changes, thus the DVID slew rate needs to be limited to prevent large inrush currents. The transition slew rate is programmed using Bits <2:0> of the Ton\_Transition (0xD6) command code. Table 6 provides the soft-start values.

| Code | Transition Rate (V/msec) |
|------|--------------------------|
| 000  | 1                        |
| 001  | 3 = default              |
| 010  | 5                        |
| 011  | 7                        |
| 100  | 9                        |
| 101  | 11                       |
| 110  | 13                       |
| 111  | 15                       |

#### **Table 6. Transition Rate Codes**

#### Enhanced Transients Mode

The ADP4000 incorporates enhanced transient response for both load step up and load release. For load step up it senses the output of the error amp to determine if a load step up has occurred and then sequences on the appropriate number of phases to ramp up the output current.

For load release, it also senses the output of the error amp and uses the load release information to trigger the TRDET pin, which is then used to adjust the error amp feedback for optimal positioning. This is especially important during high frequency load steps.

Additional information is used during load transients to ensure proper sequencing and balancing of phases during high frequency load steps as well as minimizing the stress on components such as the input filter and MOSFET's.

#### **TRDET and Phase Shuffling**

The ADP4000 senses the error amp output and triggers the TRDET pin when a load release takes place. The TRDET circuit, as shown in Figure 2, adjusts the feedback for optimal positioning especially during high frequency load steps. TRDET is also used to trigger phase shuffling. If repeated transients take place at the switching frequency then its possible for one phase to carry most of the currrent. To prevent this from happening the ADP4000 will shuffle the phases whenever a load release happens, i.e. it will randomize the phase sequence.

#### **Reference Current**

The IREF pin is used to set an internal current reference. This reference current sets  $I_{FB}$  and  $I_{TTSENSE}$ . A resistor to ground programs the current based on the 1.8 V output.

$$I_{\mathsf{REF}} = \frac{1.8 \, \mathsf{V}}{\mathsf{R}_{\mathsf{IREF}}} \tag{eq. 16}$$

Typically,  $R_{IREF}$  is set to 121 k $\Omega$  to program  $I_{REF}$  = 15  $\mu$ A. The following currents are then equal to

$$I_{FB} = \frac{16}{15} \times I_{REF} = 16 \,\mu A$$
(eq. 17)
$$I_{TTSENSE} = -8 (IREF) = -120 \,\mu A$$

#### **Power Good Monitoring**

The power good comparator monitors the output voltage via the CSREF pin. The PWRGD pin is an open-drain output whose high level (when connected to a pull-up resistor) indicates that the output voltage is within the nominal limits specified in the specifications above based on the VID voltage setting. PWRGD goes low if the output voltage is outside of this specified range, if the VID DAC inputs are in no CPU mode, or whenever the EN pin is pulled low. PWRGD is blanked during a DVID event for a period of 100 µs to prevent false signals during the time the output is changing.

The PWRGD circuitry also incorporates an initial turn-on delay time (TD5). Prior to the SS voltage reaching the programmed VID DAC voltage and the PWRGD masking time finishing, the PWRGD pin is held low. Once the SS circuit reaches the programmed DAC voltage, the internal timer operates.

The default range for the PWRGD comparator is +300 mV and -500 mV. However these values can be adjusted over the l<sup>2</sup>C. The high limit is programmed using Bits <1:0> of Command Code 0xE0 and the low limit is programmed using Bits <2:0> of Command code 0xE1. The following is a table of the programmable values.

#### Table 7. PWRGD High Limits

| Code | PWRGD High Limits |
|------|-------------------|
| 00   | +300mV (default)  |
| 01   | +250 mV           |
| 10   | +200 mV           |
| 11   | +150 mV           |

#### Table 8. PWRGD Low Limits

| Code | PWRGD Low Limits |
|------|------------------|
| 000  | -500mV (default) |
| 001  | -450 mV          |
| 010  | -400 mV          |
| 011  | -350 mV          |
| 100  | -300 mV          |
| 101  | -250 mV          |
| 110  | -200 mV          |
| 111  | -150 mV          |

#### **Power State Indicator**

The PSI pin is an input used to determine the operating state of the load. If this input is pulled low, the load is in a low power state and the controller asserts the ODN pin low, which can be used to disable phases and maintain better efficiency at lighter loads.

The sequencing into and out of low power operation is maintained to minimize output deviations as well as providing full power load transients immediately after exiting a low power state. The user can program how many phases are enabled when  $\overline{PSI}$  is asserted. By default only phase 1 is enabled. The number of phases enabled can be changed over the I<sup>2</sup>C interface. However extreme care should be taken to ensure that  $\overline{OD1}$  is connected to all phases enabled during  $\overline{PSI}$ . The number of phases enabled during  $\overline{PSI}$  is programmed using Bits 7 and 6 of the MFR Config Command (0xD1)

| # of Phases<br>Running<br>Normally | Code | # of Phases<br>Running<br>During PSI | Phases<br>Running |
|------------------------------------|------|--------------------------------------|-------------------|
| 6                                  | 00   | 1                                    | 1                 |
|                                    | 01   | 2                                    | 1 and 4           |
|                                    | 10   | 3                                    | 1, 3 and 5        |
|                                    | 11   | 1                                    | 1                 |
| 5                                  | 00   | 1                                    | 1                 |
|                                    | 01   | 2                                    | 1 and 4           |
|                                    | 10   | 1                                    | 1                 |
|                                    | 11   | 1                                    | 1                 |
| 4                                  | 00   | 1                                    | 1                 |
|                                    | 01   | 2                                    | 1 and 3           |
|                                    | 10   | 1                                    | 1                 |
|                                    | 11   | 1                                    | 1                 |
| 3                                  | 00   | 1                                    | 1                 |
|                                    | 01   | 1                                    | 1                 |
|                                    | 10   | 1                                    | 1                 |
|                                    | 11   | 1                                    | 1                 |
| 2                                  | 00   | 1                                    | 1                 |
|                                    | 01   | 1                                    | 1                 |
|                                    | 10   | 1                                    | 1                 |
|                                    | 11   | 1                                    | 1                 |
| 1                                  | 00   | 1                                    | 1                 |
|                                    | 01   | 1                                    | 1                 |
|                                    | 10   | 1                                    | 1                 |
|                                    | 11   | 1                                    | 1                 |

Table 9. # Phases Enabled During PSI

The actual phases enabled depend upon how many phases are enabled for normal operation. For example if 4 phases are enabled normally and 2 during  $\overline{PSI}$ , then Phase 1 and Phase 3 will be enabled during  $\overline{PSI}$ .

#### **Output Crowbar**

As part of the protection for the load and output components of the supply, the PWM outputs are driven low (turning on the low-side MOSFETs) when the output voltage exceeds the upper crowbar threshold. This crowbar action stops once the output voltage falls below the release threshold of approximately 300 mV.

The value for the crowbar limit follows the programmable PWRGD high limit.

Turning on the low-side MOSFETs pulls down the output as the reverse current builds up in the inductors. If the output overvoltage is due to a short in the high–side MOSFET, this action current-limits the input supply or blows its fuse, protecting the microprocessor from being destroyed.

#### Output Enable and UVLO

For the ADP4000 to begin switching, the input supply current to the controller must be higher than the UVLO threshold and the EN pin must be higher than its 0.8 V threshold. This initiates a system startup sequence. If either UVLO or EN is less than their respective thresholds, the ADP4000 is disabled. This holds the PWM outputs at ground and forces PWRGD, ODN and OD1 signals low.

In the application circuit (see Figure 2), the  $\overline{OD1}$  pin should be connected to the  $\overline{OD}$  inputs of the external drivers for the phases that are always on. The  $\overline{ODN}$  pin should be connected to the  $\overline{OD}$  inputs of the external drivers on the phases that are shut down during low power operation. Grounding the driver  $\overline{OD}$  inputs disables the drivers such that both DRVH and DRVL are grounded. This feature is important in preventing the discharge of the output capacitors when the controller is shut off. If the driver outputs are not disabled, a negative voltage can be generated during output due to the high current discharge of the output capacitors through the inductors.

#### **Thermal Monitoring**

The ADP4000 includes a thermal monitoring channel using a thermistor. Temperature trip points can be set for  $\overline{\text{ALERT}}$  and  $\overline{\text{FAULT}}$  levels through the I<sup>2</sup>C interface. Also, the temperature values can be read back over the I<sup>2</sup>C interface.

The VR thermal monitoring circuits require an NTC thermistor to be placed from TTSENSE to GND. For best accuracy, the thermistors can be linearized using resistors. A fixed current of 8 times IREF (normally giving 120  $\mu$ A) is sourced out of the TTSENSE pin into the thermistor. When the TTSENSE temperature exceeds the OT Fault Limit (0x51), VRHOT is asserted.

The temperature value is reported back in the Read\_Temperature1 command. The ADP4000 measures the voltage on the TTSENSE pin and calculates the temperature using the following formula:

Read\_Temperature\_1 = (TTSENSE Voltage)\*TTSENSE Gain + TTSENSE Offset.

The TTSENSE Gain and Offset factors depend upon the combination of thermistor and linearizing register used in the circuit and can be programmed by the user using commands TTSENSE Gain (addr = 0xF7) and TTSENSE Offset (addr = 0xF8). The default values in the ADP4000 are for a 100 k Thermistor and a 20 k Linearizing resistor. If the user would like to measure the voltage directly then the TTSENSE Gain should be programmed to 1 and the Offset should be programmed to 0.

#### Voltage Monitoring

The ADP4000 can monitor up to three voltages. It can monitor the voltage on the EN pin and reports this back in a register. It can also monitor the voltage on the VSENSE1 and the VSENSE2 pins and report these back in registers over I<sup>2</sup>C. The ADC range for the voltage measurements is 0~V to 2.0 V. Voltages greater than 2.0 V can monitored using a resistor divider network. Voltage measurements are 10 bits wide.

Vsense1 is intended to measure the input voltage and report this back in the READ\_VIN command. However the input voltage is typically 12 V and the ADC range is only 0 V to 2.0 V. Therefore an external resistor divided is needed, the ADP4000 assumes that an 8–1 resistor divider is used, the ADP4000 measures the voltage on the pin and multiples by 8 and places the result in the Read V<sub>in</sub> register. The circuit in Figure 2 uses a 6.8 K and a 1.0 k resistor to divide the input voltage by 8.

#### **Shunt Resistor**

The ADP4000 uses a shunt to generate 5.0 V from the 12 V supply range. A trade-off can be made between the power dissipated in the shunt resistor and the UVLO threshold. Figure 10 shows the typical resistor value needed to realize certain UVLO voltages. It also gives the maximum power dissipated in the shunt resistor for these UVLO voltages.

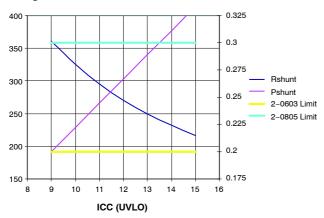


Figure 10. Typical Shunt Resistor Value and Power Dissipation for Different UVLO Voltage

The maximum power dissipated is calculated using the Equation 18.

$$\mathsf{P}_{\mathsf{MAX}} = \frac{\left(\mathsf{V}_{\mathsf{IN}(\mathsf{MAX})} - \mathsf{V}_{\mathsf{CC}(\mathsf{MIN})}\right)^2}{\mathsf{R}_{\mathsf{SHUNT}}} \qquad (\mathsf{eq. 18})$$

where:

 $V_{IN(MAX)}$  is the maximum voltage from the 12 V input supply (if the 12 V input supply is 12 V ±5%,  $V_{IN(MAX)}$  = 12.6 V; if the 12 V input supply is 12 V ±10%,  $V_{IN(MAX)}$  = 13.2 V).  $V_{CC(MIN)}$  is the minimum  $V_{CC}$  voltage of the ADP4000. This is specified as 4.75 V.

R<sub>SHUNT</sub> is the shunt resistor value.

The CECC standard specification for power rating in surface-mount resistors is: 0603 = 0.1 W, 0805 = 0.125 W, 1206 = 0.25 W.

#### I<sup>2</sup>C Interface

Control of the ADP4000 is carried out using the  $I^2C$  Interface.

The ADP4000 is connected to this bus as a slave device, under the control of a master controller.

To setup the I<sup>2</sup>C Address the ADP4000 sources a 10  $\mu$ A current from the ADD pin through an external resistor. The voltage is then measured by the ADC and user to set the I<sup>2</sup>C address. The table below gives the thresholds for each possible I<sup>2</sup>C address.

| Address (8 Bits) | High Threshold | Low Threshold |  |  |  |  |  |  |
|------------------|----------------|---------------|--|--|--|--|--|--|
| 0xC0             | 0.1            | -             |  |  |  |  |  |  |
| 0xC2             | 0.225          | 0.15          |  |  |  |  |  |  |
| 0xC4             | 0.45           | 0.3           |  |  |  |  |  |  |
| 0xC6             | 0.675          | 0.5           |  |  |  |  |  |  |
| 0xC8             | 0.9            | 0.75          |  |  |  |  |  |  |
| 0xCA             | 1.25           | 1.0           |  |  |  |  |  |  |
| 0xCC             | 1.7            | 1.35          |  |  |  |  |  |  |
| 0xCE             | _              | 1.8           |  |  |  |  |  |  |

Table 10. Setting Up the I<sup>2</sup>C Address

Data is sent over the serial bus in sequences of nine clock pulses: eight bits of data followed by an acknowledge bit from the slave device. Transitions on the data line must occur during the low period of the clock signal and remain stable during the high period, because a low-to-high transition when the clock is high might be interpreted as a stop signal. The number of data bytes that can be transmitted over the serial bus in a single read or write operation is limited only by what the master and slave devices can handle.

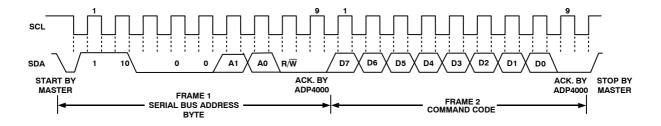
1. When all data bytes have been read or written, stop conditions are established. In write mode, the master pulls the data line high during the tenth clock pulse to assert a stop condition. In read mode, the master device overrides the acknowledge bit by pulling the data line high during the low period before the ninth clock pulse; this is known as No Acknowledge. The master takes the data line low during the low period before the tenth clock pulse, and then high during the tenth clock pulse to assert a stop condition. Any number of bytes of data can be transferred over the serial bus in one operation, but it is not possible to mix read and write in one operation because the type of operation is determined at the beginning and cannot subsequently be changed without starting a new operation.

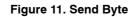
In the ADP4000, write operations contain one, two or three bytes, and read operations contain one or two bytes. The command code or register address determines the number of bytes to be read or written, See the register map for more information.

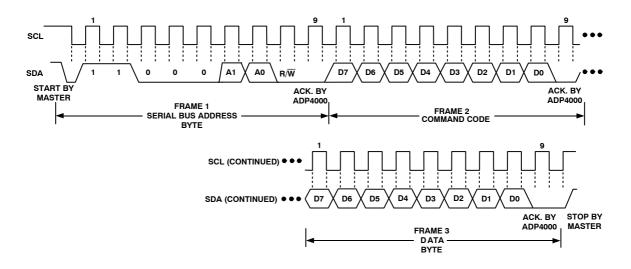
To write data to one of the device data registers or read data from it, the address pointer register must be set so that the correct data register is addressed (i.e. command code), and then data can be written to that register or read from it. The first byte of a read or write operation always contains an address that is stored in the address pointer register. If data is to be written to the device, the write operation contains a second data byte that is written to the register selected by the address pointer register.

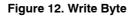
This write byte operation is shown in Figure 12. The device address is sent over the bus, and then  $R/\overline{W}$  is set to 0. This is followed by two data bytes. The first data byte is the address of the internal data register to be written to, which is stored in the address pointer register. The second data byte is the data to be written to the internal data register.

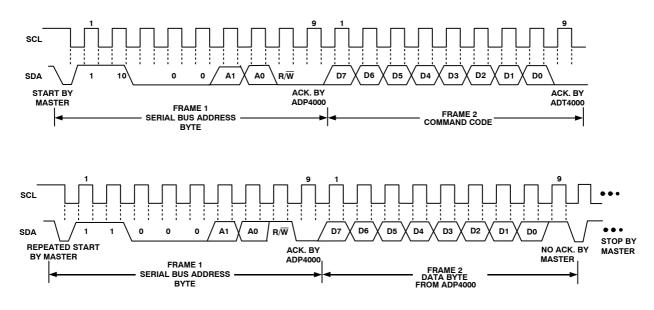
- 2. The read byte operation is shown in Figure 13. First the command code needs to be written to the ADP4000 so that the required data is sent back. This is done by performing a write to the ADP4000 as before, but only the data byte containing the register address is sent, because no data is written to the register. A repeated start is then issued and a read operation is then performed consisting of the serial bus address; R/W bit set to 1, followed by the data byte read from the data register.
- 3. It is not possible to read or write a data byte from a data register without first writing to the address pointer register, even if the address pointer register is already at the correct value.
- 4. In addition to supporting the send byte, the ADP4000 also supports the read byte, write byte, read word and write word protocols.











#### Figure 13. Read Byte

## Write Operations

The following abbreviations are used in the diagrams:

S–START P–STOP R–READ W–WRITE A–ACKNOWLEDGE A–NO ACKNOWLEDGE

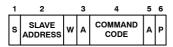
The ADP4000 uses the following I<sup>2</sup>C write protocols.

#### Send Byte

In this operation, the master device sends a single command byte to a slave device as follows:

- 1. The master device asserts a start condition on SDA.
- 2. The master sends the 7-bit slave address followed by the write bit (low).
- 3. The addressed slave device asserts ACK on SDA.
- 4. The master sends a command code.
- 5. The slave asserts ACK on SDA.
- 6. The master asserts a stop condition on SDA and the transaction ends.

For the ADP4000, the send byte protocol is used to clear Faults. This operation is shown in Figure 14.



#### Figure 14. Send Byte Command

If the master is required to read data from the register immediately after setting up the address, it can assert a repeat start condition immediately after the final ACK and carry out a single byte read without asserting an intermediate stop condition.

#### Write Byte

In this operation, the master device sends a command byte and one data byte to the slave device as follows:

- 1. The master device asserts a start condition on SDA.
- 2. The master sends the 7-bit slave address followed by the write bit (low).
- 3. The addressed slave device asserts ACK on SDA.
- 4. The master sends a command code.
- 5. The slave asserts ACK on SDA.
- 6. The master sends a data byte.
- 7. The slave asserts ACK on SDA.
- 8. The master asserts a stop condition on SDA and the transaction ends.

The byte write operation is shown in Figure 15.

| 1 | 2                |   | 3 | 4               | 5 | 6    | 7 | 8 |  |
|---|------------------|---|---|-----------------|---|------|---|---|--|
| s | SLAVE<br>ADDRESS | w | A | COMMAND<br>CODE | A | DATA | A | Ρ |  |

#### Figure 15. Single Byte Write to a Register

#### Write Word

In this operation, the master device sends a command byte and two data bytes to the slave device as follows:

- 1. The master device asserts a start condition on SDA.
- 2. The master sends the 7-bit slave address followed by the write bit (low).
- 3. The addressed slave device asserts ACK on SDA.
- 4. The master sends a command code.
- 5. The slave asserts ACK on SDA.
- 6. The master sends the first data byte.
- 7. The slave asserts ACK on SDA.
- 8. The master sends the second data byte.
- 9. The slave asserts ACK on SDA.

10. The master asserts a stop condition on SDA and the transaction ends.

The word write operation is shown in Figure 16.

| 1 | 2                |   | 3 | 4               | 5 | 6             | 7 | 8             | 9 | 10 |
|---|------------------|---|---|-----------------|---|---------------|---|---------------|---|----|
| s | SLAVE<br>ADDRESS | w | A | COMMAND<br>CODE | A | DATA<br>(LSB) | A | DATA<br>(MSB) | A | P  |

#### Figure 16. Single Word Write to a Register

#### **Block Write**

In this operation, the master device sends a command byte and a byte count followed by the stated number of data bytes to the slave device as follows:

- 1. The master device asserts a START condition on SDA.
- 2. The master sends the 7-bit slave address followed by the write bit (low).
- 3. The addressed slave device asserts ACK on SDA.
- 4. The master sends a command code.
- 5. The slave asserts ACK on SDA.
- 6. The master sends the byte count N.
- 7. The slave asserts ACK on SDA.
- 8. The master sends the first data byte.
- 9. The slave asserts ACK on SDA.
- 10. The master sends the second data byte.
- 11. The slave asserts ACK on SDA.
- 12. The master sends the remainder of the data byes.
- 13. The slave asserts an ACK on SDA after each data byte.
- 14. After the last data byte the master asserts a STOP condition on SDA.

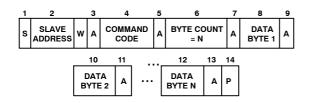


Figure 17. Block Write to a Register

#### **Read Operations**

The ADP4000 uses the following I<sup>2</sup>C read protocols.

#### **Read Byte**

In this operation, the master device receives a single byte from a slave device as follows:

- 1. The master device asserts a start condition on SDA.
- 2. The master sends the 7-bit slave address followed by the write bit (low).
- 3. The addressed slave device asserts ACK on SDA.
- 4. The master sends a command code.
- 5. The slave asserted ACK on SDA.
- 6. The master sends a repeated start condition on SDA.
- 7. The master sends the 7 bit slave address followed by the read bit (high).
- 8. The slave asserts ACK on SDA.

- 9. The slave sends the Data Byte.
- 10. The master asserts NO ACK on SDA.
- 11. The master asserts a stop condition on SDA and the transaction ends.

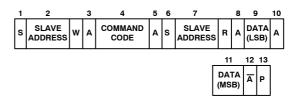
| 1 | 2                |   | 3 | 4               | 5 | 6 | 7                |   | 8 | 9    | 10 | 11 |
|---|------------------|---|---|-----------------|---|---|------------------|---|---|------|----|----|
| s | SLAVE<br>ADDRESS | w | A | COMMAND<br>CODE | A | s | SLAVE<br>ADDRESS | R | A | DATA | Ā  | Ρ  |

#### Figure 18. Single Read from a Register

#### Read Word

In this operation, the master device receives two data bytes from a slave device as follows:

- 1. The master device asserts a start condition on SDA.
- 2. The master sends the 7-bit slave address followed by the write bit (low).
- 3. The addressed slave device asserts ACK on SDA.
- 4. The master sends a command code.
- 5. The slave asserted ACK on SDA.
- 6. The master sends a repeated start condition on SDA.
- 7. The master sends the 7 bit slave address followed by the read bit (high).
- 8. The slave asserts ACK on SDA.
- 9. The slave sends the first Data Byte (low Data Byte).
- 10. The master asserts ACK on SDA.
- 11. The slave sends the second Data Byte (high Data Byte).
- 12. The masters asserts a No ACK on SDA.
- 13. The master asserts a stop condition on SDA and the transaction ends.



#### Figure 19. Word Read from a Command Code

#### Block Read

In this operation, the master device sends a command byte, the slave sends a byte count followed by the stated number of data bytes to the master device as follows:

- 1. The master device asserts a START condition on SDA.
- 2. The master sends the 7-bit slave address followed by the write bit (low).
- 3. The addressed slave device asserts ACK on SDA.
- 4. The master sends a REPEATED START condition on SDA.
- 5. The master sends the 7-bit slave address followed by the read bit (high).
- 6. The slave asserts ACK on SDA
- 7. The slave sends the byte count N.

- 8. The master asserts ACK on SDA.
- 9. The slave sends the first data byte
- 10. The master asserts ACK on SDA.
- 11. The slave sends the remainder of the data byes, the master asserts an ACK on SDA after each data byte.
- 12. After the last data byte the master asserts a No ACK on SDA.
- 13. The master asserts a STOP condition on SDA.

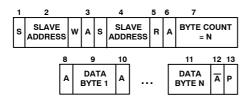


Figure 20. Block Write to a Command Coder

#### **Bus Timeout**

The ADP4000 includes an I<sup>2</sup>C timeout feature. If there is no I<sup>2</sup>C activity for 35 ms, the ADP4000 assumes that the bus is locked and releases the bus. This prevents the device from locking or holding the I<sup>2</sup>C expecting data. The timeout feature can be disabled.

### Configuration Register 1 (0xTBD)

Bit 3 BUS\_TO\_EN = 1; bus timeout enabled. Bit 3 TODIS = 0;  $I^2C$  timeout disabled (default).

#### Virus Protection

To prevent rogue programs or viruses from accessing critical ADP4000 register settings, the lock bit can be set. Setting Bit 0 of the Lock/Reset sets the lock bit and locks critical registers. In this mode, certain registers can no longer be written to until the ADP4000 is powered down and powered up again. For more information on which registers are locked see the register map.

#### ON\_OFF\_Config Command

The I<sup>2</sup>C interface has an ON\_OFF\_Config which allows the user to configure when the ADP4000 should start and stop switching. There two control inputs, the EN input (specified as per VR11.1) and the Operation Command. The user can program the ADP4000 to respond to or ignore each of the control inputs. The default configuration is the EN pin is acted on, and the Operation Command is ignored. The EN pin is active high by default but can be programmed to be active low over I<sup>2</sup>C. The details of the individual bits can be found in the description for Command Code 0x02 (ON\_OFF\_Config) in Table 11.

## **Operation Command**

The operation command, when enabled in the ON\_OFF\_Config command, can be used to start and stop the ADP4000 switching. The options available described in the Operation Command (0x01) in Table 11. There are two options for turning off, soft off and immediate off. There are

three options for turning on. The first is ON, where the output voltage is soft started towards the Boot Voltage and then to the VID Voltage (same startup sequence as toggling EN). The other two options are margin high and margin low. When these options are selected the output voltage will settle on the VOUT\_MARGIN\_HIGH VID Code (0x25) or the VOUT\_MARGIN\_LOW VID Code (0x26).

## Limits, ALERTs, and FAULTs

The ADP4000 monitors a number of voltage rails, temperatures, current etc. For each of the measured values there are ALERT and FAULT limits. When an ALERT or FAULT limit is exceeded then the ALERT or FAULT pin is asserted low and will remain low until the I<sup>2</sup>C master does a Clear Faults command and the measured value is back within the programmed limits. Take for example the temperature measurement Read Temperature1 (0x8D). This value is compared with the OT WARN LIMIT (0x51) and the UT\_WARN\_LIMIT (0x52). If the measured temperature goes above the OT\_WARN\_LIMIT or under the UT\_WARN\_LIMIT then the corresponding Status bit is set Status Temperature Command (0x7D) and an ALERT pin is pulled low. The ALERT pin will remain low until the I<sup>2</sup>C master does a Clear Faults command (0x03) and the measured temperature is back within the programmed limits. If the measured temperature exceeds the  $OT_{FAULT}_{LIMIT}$  (0x51) then Bit 7 of the Status Temperature command gets set and the FAULT pin is asserted low. The intention is that a FAULT condition is worse than an ALERT condition.

Each measured value is compared with appropriate high and low limits and the results of these comparisons are stored in Status Registers. See details of the various status registers in Table 11, commands 0x78, STATUS BYTE to 0x80 STATUS ALERT.

The ADP4000 also allows the user to program which measured values can generate an ALERT and a FAULT using the Mask ALERT (0xF9) and Mask FAULT (0xFA) Commands. If the Mask VOUT Bit (Bit 7 is set in the Mask ALERT command) then the measured Vout going outside the programmed limits will set the appropriate Status bit but will not assert ALERT pin low. See command codes 0xF9 and 0xFA in Table 11 for more details.

## Linear Mode

Linear Mode is used for reporting back voltage, current and temperatures etc and for programming Limits. The ADP4000 uses Linear Mode. Linear Mode can be decoded as follows:

 $X = Y^2N$ 

Where X = the value (for example if this is current then it would be Amps, Temperature it would be  $^{\circ}C$  etc). The register readback is 16 Bits, the 5 MSB's are the Exponent (=N) and the 11 LSB's are the mantissa (=Y). Both the

mantissa and exponent are 2's compliment values, if the MSB are 1 then they are negative values.

## IOUT\_CAL\_GAIN and IOUT\_CAL\_OFFSET

The ADP4000 measures the voltage on the Imon pin and stores that in the READ\_IOUT Command (0x8C). However this register should read back Amps. Therefore the IOUT\_CAL\_GAIN and IOUT\_CAL\_OFFSET commands need to be programmed to convert the Imon voltage into current in Amps. The following equation is used:

 $\mathsf{READ\_IOUT} = \left(\mathsf{I}_{\mathsf{MON}} \: \mathsf{Voltage} \times \: \mathsf{IOUT\_CAL\_GAIN}\right)$ 

+ IOUT\_CAL\_OFFSET

(eq. 19)

The IOUT\_CAL\_GAIN defaults to 1 and IOUT\_CAL\_OFFSET defaults to 0 which means the Imon voltage is stored in the READ IOUT Command.

#### OUTPUT VID7 VID6 VID5 VID4 VID3 VID2 VID1 VIDO OFF OFF 1.60000 1.59375 1.58750 1.58125 1.57500 1.56875 1.56250 1.55625 1.55000 1.54375 1.53750 1.53125 1.52500 1.51875 1.51250 1.50625 1.50000 1.49375 1.48750 1.48125 1.47500 1.46875 1.46250 1.45625 1.45000 1.44375 1.43750 1.43125 1.42500 1.41875 1.41250 1.40625 1.40000 1.39375 1.38750 1.38125 1.37500 1.36875 1.36250 1.35625 1.35000 1.34375

#### VR11 VID CODES for the ADP4000

1.33750

1.33125

| <b>VR11</b> | <b>VID CODES</b> | for the ADP4000 |
|-------------|------------------|-----------------|
|-------------|------------------|-----------------|

| OUTPUT  | VID7 | VID6 | VID5 | VID4 | VID3 | VID2 | VID1 | VID0 |
|---------|------|------|------|------|------|------|------|------|
| 1.32500 | 0    | 0    | 1    | 0    | 1    | 1    | 1    | 0    |
| 1.31875 | 0    | 0    | 1    | 0    | 1    | 1    | 1    | 1    |
| 1.31250 | 0    | 0    | 1    | 1    | 0    | 0    | 0    | 0    |
| 1.30625 | 0    | 0    | 1    | 1    | 0    | 0    | 0    | 1    |
| 1.30000 | 0    | 0    | 1    | 1    | 0    | 0    | 1    | 0    |
| 1.29375 | 0    | 0    | 1    | 1    | 0    | 0    | 1    | 1    |
| 1.28750 | 0    | 0    | 1    | 1    | 0    | 1    | 0    | 0    |
| 1.28125 | 0    | 0    | 1    | 1    | 0    | 1    | 0    | 1    |
| 1.27500 | 0    | 0    | 1    | 1    | 0    | 1    | 1    | 0    |
| 1.26875 | 0    | 0    | 1    | 1    | 0    | 1    | 1    | 1    |
| 1.26250 | 0    | 0    | 1    | 1    | 1    | 0    | 0    | 0    |
| 1.25625 | 0    | 0    | 1    | 1    | 1    | 0    | 0    | 1    |
| 1.25000 | 0    | 0    | 1    | 1    | 1    | 0    | 1    | 0    |
| 1.24375 | 0    | 0    | 1    | 1    | 1    | 0    | 1    | 1    |
| 1.23750 | 0    | 0    | 1    | 1    | 1    | 1    | 0    | 0    |
| 1.23125 | 0    | 0    | 1    | 1    | 1    | 1    | 0    | 1    |
| 1.22500 | 0    | 0    | 1    | 1    | 1    | 1    | 1    | 0    |
| 1.21875 | 0    | 0    | 1    | 1    | 1    | 1    | 1    | 1    |
| 1.21250 | 0    | 1    | 0    | 0    | 0    | 0    | 0    | 0    |
| 1.20625 | 0    | 1    | 0    | 0    | 0    | 0    | 0    | 1    |
| 1.20000 | 0    | 1    | 0    | 0    | 0    | 0    | 1    | 0    |
| 1.19375 | 0    | 1    | 0    | 0    | 0    | 0    | 1    | 1    |
| 1.18750 | 0    | 1    | 0    | 0    | 0    | 1    | 0    | 0    |
| 1.18125 | 0    | 1    | 0    | 0    | 0    | 1    | 0    | 1    |
| 1.17500 | 0    | 1    | 0    | 0    | 0    | 1    | 1    | 0    |
| 1.16875 | 0    | 1    | 0    | 0    | 0    | 1    | 1    | 1    |
| 1.16250 | 0    | 1    | 0    | 0    | 1    | 0    | 0    | 0    |
| 1.15625 | 0    | 1    | 0    | 0    | 1    | 0    | 0    | 1    |
| 1.15000 | 0    | 1    | 0    | 0    | 1    | 0    | 1    | 0    |
| 1.14375 | 0    | 1    | 0    | 0    | 1    | 0    | 1    | 1    |
| 1.13750 | 0    | 1    | 0    | 0    | 1    | 1    | 0    | 0    |
| 1.13125 | 0    | 1    | 0    | 0    | 1    | 1    | 0    | 1    |
| 1.12500 | 0    | 1    | 0    | 0    | 1    | 1    | 1    | 0    |
| 1.11875 | 0    | 1    | 0    | 0    | 1    | 1    | 1    | 1    |
| 1.11250 | 0    | 1    | 0    | 1    | 0    | 0    | 0    | 0    |
| 1.10625 | 0    | 1    | 0    | 1    | 0    | 0    | 0    | 1    |
| 1.10000 | 0    | 1    | 0    | 1    | 0    | 0    | 1    | 0    |
| 1.09375 | 0    | 1    | 0    | 1    | 0    | 0    | 1    | 1    |
| 1.08750 | 0    | 1    | 0    | 1    | 0    | 1    | 0    | 0    |
| 1.08125 | 0    | 1    | 0    | 1    | 0    | 1    | 0    | 1    |
| 1.07500 | 0    | 1    | 0    | 1    | 0    | 1    | 1    | 0    |
| 1.06875 | 0    | 1    | 0    | 1    | 0    | 1    | 1    | 1    |
| 1.06250 | 0    | 1    | 0    | 1    | 1    | 0    | 0    | 0    |
| 1.05625 | 0    | 1    | 0    | 1    | 1    | 0    | 0    | 1    |
| 1.05000 | 0    | 1    | 0    | 1    | 1    | 0    | 1    | 0    |
| 1.04375 | 0    | 1    | 0    | 1    | 1    | 0    | 1    | 1    |

#### VR11 VID CODES for the ADP4000

| OUTPUT  | VID7 | VID6 | VID5 | VID4 | VID3 | VID2 | VID1 | VID0 |
|---------|------|------|------|------|------|------|------|------|
| 1.03750 | 0    | 1    | 0    | 1    | 1    | 1    | 0    | 0    |
| 1.03125 | 0    | 1    | 0    | 1    | 1    | 1    | 0    | 1    |
| 1.02500 | 0    | 1    | 0    | 1    | 1    | 1    | 1    | 0    |
| 1.01875 | 0    | 1    | 0    | 1    | 1    | 1    | 1    | 1    |
| 1.01250 | 0    | 1    | 1    | 0    | 0    | 0    | 0    | 0    |
| 1.00625 | 0    | 1    | 1    | 0    | 0    | 0    | 0    | 1    |
| 1.00000 | 0    | 1    | 1    | 0    | 0    | 0    | 1    | 0    |
| 0.99375 | 0    | 1    | 1    | 0    | 0    | 0    | 1    | 1    |
| 0.98750 | 0    | 1    | 1    | 0    | 0    | 1    | 0    | 0    |
| 0.98125 | 0    | 1    | 1    | 0    | 0    | 1    | 0    | 1    |
| 0.97500 | 0    | 1    | 1    | 0    | 0    | 1    | 1    | 0    |
| 0.96875 | 0    | 1    | 1    | 0    | 0    | 1    | 1    | 1    |
| 0.96250 | 0    | 1    | 1    | 0    | 1    | 0    | 0    | 0    |
| 0.95625 | 0    | 1    | 1    | 0    | 1    | 0    | 0    | 1    |
| 0.95000 | 0    | 1    | 1    | 0    | 1    | 0    | 1    | 0    |
| 0.94375 | 0    | 1    | 1    | 0    | 1    | 0    | 1    | 1    |
| 0.93750 | 0    | 1    | 1    | 0    | 1    | 1    | 0    | 0    |
| 0.93125 | 0    | 1    | 1    | 0    | 1    | 1    | 0    | 1    |
| 0.92500 | 0    | 1    | 1    | 0    | 1    | 1    | 1    | 0    |
| 0.91875 | 0    | 1    | 1    | 0    | 1    | 1    | 1    | 1    |
| 0.91250 | 0    | 1    | 1    | 1    | 0    | 0    | 0    | 0    |
| 0.90625 | 0    | 1    | 1    | 1    | 0    | 0    | 0    | 1    |
| 0.90000 | 0    | 1    | 1    | 1    | 0    | 0    | 1    | 0    |
| 0.89375 | 0    | 1    | 1    | 1    | 0    | 0    | 1    | 1    |
| 0.88750 | 0    | 1    | 1    | 1    | 0    | 1    | 0    | 0    |
| 0.88125 | 0    | 1    | 1    | 1    | 0    | 1    | 0    | 1    |
| 0.87500 | 0    | 1    | 1    | 1    | 0    | 1    | 1    | 0    |
| 0.86875 | 0    | 1    | 1    | 1    | 0    | 1    | 1    | 1    |
| 0.86250 | 0    | 1    | 1    | 1    | 1    | 0    | 0    | 0    |
| 0.85625 | 0    | 1    | 1    | 1    | 1    | 0    | 0    | 1    |
| 0.85000 | 0    | 1    | 1    | 1    | 1    | 0    | 1    | 0    |
| 0.84375 | 0    | 1    | 1    | 1    | 1    | 0    | 1    | 1    |
| 0.83750 | 0    | 1    | 1    | 1    | 1    | 1    | 0    | 0    |
| 0.83125 | 0    | 1    | 1    | 1    | 1    | 1    | 0    | 1    |
| 0.82500 | 0    | 1    | 1    | 1    | 1    | 1    | 1    | 0    |
| 0.81875 | 0    | 1    | 1    | 1    | 1    | 1    | 1    | 1    |
| 0.81250 | 1    | 0    | 0    | 0    | 0    | 0    | 0    | 0    |
| 0.80625 | 1    | 0    | 0    | 0    | 0    | 0    | 0    | 1    |
| 0.80000 | 1    | 0    | 0    | 0    | 0    | 0    | 1    | 0    |
| 0.79375 | 1    | 0    | 0    | 0    | 0    | 0    | 1    | 1    |
| 0.78750 | 1    | 0    | 0    | 0    | 0    | 1    | 0    | 0    |
| 0.78125 | 1    | 0    | 0    | 0    | 0    | 1    | 0    | 1    |
| 0.77500 | 1    | 0    | 0    | 0    | 0    | 1    | 1    | 0    |
| 0.76875 | 1    | 0    | 0    | 0    | 0    | 1    | 1    | 1    |
| 0.76250 | 1    | 0    | 0    | 0    | 1    | 0    | 0    | 0    |
| 0.75625 | 1    | 0    | 0    | 0    | 1    | 0    | 0    | 1    |

#### VR11 VID CODES for the ADP4000

| OUTPUT  | VID7 | VID6 | VID5 | VID4 | VID3 | VID2 | VID1 | VID0 |
|---------|------|------|------|------|------|------|------|------|
| 0.75000 | 1    | 0    | 0    | 0    | 1    | 0    | 1    | 0    |
| 0.74375 | 1    | 0    | 0    | 0    | 1    | 0    | 1    | 1    |
| 0.73750 | 1    | 0    | 0    | 0    | 1    | 1    | 0    | 0    |
| 0.73125 | 1    | 0    | 0    | 0    | 1    | 1    | 0    | 1    |
| 0.72500 | 1    | 0    | 0    | 0    | 1    | 1    | 1    | 0    |
| 0.71875 | 1    | 0    | 0    | 0    | 1    | 1    | 1    | 1    |
| 0.71250 | 1    | 0    | 0    | 1    | 0    | 0    | 0    | 0    |
| 0.70625 | 1    | 0    | 0    | 1    | 0    | 0    | 0    | 1    |
| 0.70000 | 1    | 0    | 0    | 1    | 0    | 0    | 1    | 0    |
| 0.69375 | 1    | 0    | 0    | 1    | 0    | 0    | 1    | 1    |
| 0.68750 | 1    | 0    | 0    | 1    | 0    | 1    | 0    | 0    |
| 0.68125 | 1    | 0    | 0    | 1    | 0    | 1    | 0    | 1    |
| 0.67500 | 1    | 0    | 0    | 1    | 0    | 1    | 1    | 0    |
| 0.66875 | 1    | 0    | 0    | 1    | 0    | 1    | 1    | 1    |
| 0.66250 | 1    | 0    | 0    | 1    | 1    | 0    | 0    | 0    |
| 0.65625 | 1    | 0    | 0    | 1    | 1    | 0    | 0    | 1    |
| 0.65000 | 1    | 0    | 0    | 1    | 1    | 0    | 1    | 0    |
| 0.64375 | 1    | 0    | 0    | 1    | 1    | 0    | 1    | 1    |
| 0.63750 | 1    | 0    | 0    | 1    | 1    | 1    | 0    | 0    |
| 0.63125 | 1    | 0    | 0    | 1    | 1    | 1    | 0    | 1    |
| 0.62500 | 1    | 0    | 0    | 1    | 1    | 1    | 1    | 0    |
| 0.61875 | 1    | 0    | 0    | 1    | 1    | 1    | 1    | 1    |
| 0.61250 | 1    | 0    | 1    | 0    | 0    | 0    | 0    | 0    |
| 0.60625 | 1    | 0    | 1    | 0    | 0    | 0    | 0    | 1    |
| 0.60000 | 1    | 0    | 1    | 0    | 0    | 0    | 1    | 0    |
| 0.59375 | 1    | 0    | 1    | 0    | 0    | 0    | 1    | 1    |
| 0.58750 | 1    | 0    | 1    | 0    | 0    | 1    | 0    | 0    |
| 0.58125 | 1    | 0    | 1    | 0    | 0    | 1    | 0    | 1    |
| 0.57500 | 1    | 0    | 1    | 0    | 0    | 1    | 1    | 0    |
| 0.56875 | 1    | 0    | 1    | 0    | 0    | 1    | 1    | 1    |
| 0.56250 | 1    | 0    | 1    | 0    | 1    | 0    | 0    | 0    |
| 0.55625 | 1    | 0    | 1    | 0    | 1    | 0    | 0    | 1    |
| 0.55000 | 1    | 0    | 1    | 0    | 1    | 0    | 1    | 0    |
| 0.54375 | 1    | 0    | 1    | 0    | 1    | 0    | 1    | 1    |
| 0.53750 | 1    | 0    | 1    | 0    | 1    | 1    | 0    | 0    |
| 0.53125 | 1    | 0    | 1    | 0    | 1    | 1    | 0    | 1    |
| 0.52500 | 1    | 0    | 1    | 0    | 1    | 1    | 1    | 0    |
| 0.51875 | 1    | 0    | 1    | 0    | 1    | 1    | 1    | 1    |
| 0.51250 | 1    | 0    | 1    | 1    | 0    | 0    | 0    | 0    |
| 0.50625 | 1    | 0    | 1    | 1    | 0    | 0    | 0    | 1    |
| 0.50000 | 1    | 0    | 1    | 1    | 0    | 0    | 1    | 0    |
| OFF     | 1    | 1    | 1    | 1    | 1    | 1    | 1    | 0    |
| OFF     | 1    | 1    | 1    | 1    | 1    | 1    | 1    | 1    |

| Table 11. | I <sup>2</sup> C Comr | nands for t | the ADP4000 |
|-----------|-----------------------|-------------|-------------|
|-----------|-----------------------|-------------|-------------|

| Cmd<br>Code | R/W | Default | Description   | #<br>Byte |                               |  | Comment  |
|-------------|-----|---------|---------------|-----------|-------------------------------|--|--|
| 0x01        | R/W | 0x80    | Operation     | 1         | 01xx xx<br>1000 xx<br>1001 10 | xx – Immediate Off<br>xx – Soft Off<br>xx – On (slew rate set<br>xx – Margin Low (Act<br>xx – Margin High (Act |  |
| 0x02        | R/W | 0x17    | ON_OFF_Config | 1         | Configu                       | res how the controller   | is turned on and off   |
|             |     |         |               |           | Bit                           | Default  | Comment  |
|             |     |         |               |           | 7:5                           | 1  | Reserved for Future Use  |
|             |     |         |               |           | 4                             | 0  | This bit is read only. Switching<br>starts when commanded by the<br>Control Pin and the Operation<br>Command, as set in Bits 3:0   |
|             |     |         |               |           | 3                             | 1  | 0: Unit ignores OPERATION<br>commands over the I <sup>2</sup> C interface<br>1: Unit responds to OPERATION<br>command, powerup may also<br>depend upon Control input, as<br>described in Bit 2 |
|             |     |         |               |           | 2                             | 1  | 0: Unit ignores EN pin<br>1: Unit responds EN pin, powerup<br>may also depend upon the<br>Operation Register, as described<br>for Bit 3  |
|             |     |         |               |           | 1                             | 1  | Control Pin Polarity<br>0 = Active Low<br>1 = Active High  |
|             |     |         |               |           | 0                             | 1  | This bit is read only. 1 means that<br>when the controller is disabled it<br>will either immediately turn off or<br>soft off (as set in the Operation<br>Command)                              |
| 0x03        | W   | NA      | Clear_Faults  | 0         | immedia                       | ately. The SMBus ALE   | nand code will clear all Status Bits<br>RT is deasserted on this command. If<br>It bit shall immediately be asserted   |
| 0x10        | R/W | 0x00    | Write Protect | 1         | device.<br>that onc           | There is also a lock bit   | s used to control writing to the I <sup>2</sup> C<br>in the Manufacture Specific Registers<br>s to all commands until the power to the   |
|             |     |         |               |           |                               | Data Byte  | Comment  |
|             |     |         |               |           |                               | 1000 0000  | Disables all writes except to the Write_Protect Command  |
|             |     |         |               |           |                               | 0100 0000  | Disables all writes except to the<br>Write_Protect and Operation<br>Commands   |
|             |     |         |               |           |                               | 0010 0000  | Disables all writes except to the<br>Write_Protect, Operation,<br>ON_OFF_Config and<br>V <sub>OUT</sub> _COMMAND Commands  |
|             |     |         |               |           |                               | 0000 0000  | Enables writes to all commands   |
|             |     |         |               |           |                               | 0001 0000  | Disables all writes except to<br>WRITE_PROTECT, PAGE and all<br>MFR-SPECIFIC Commands  |
| 0x19        | R   | 0xB0    | Capability    | 1         | This cor<br>device.           | nmand allows the host  | t to get some information on the I <sup>2</sup> C  |
|             |     |         |               |           | Bit                           | Default  | Comment  |
|             |     |         |               |           | 7                             | 1  | PEC (Packet Error Checking is supported).  |
|             |     |         |               |           | 6:5                           | 01   | Max supported bus speed is 400 kHz.  |

| Cmd<br>Code | R/W | Default | Description             | #<br>Byte |   | Co  | omment  |  |
|-------------|-----|---------|-------------------------|-----------|---|---|---|--|
|             |     |         |                         |           | 4   | 1   | ADP4000 has an SMBus ALERT pin and ARA is supported.  |  |
|             |     |         |                         |           | 3:0   | 000   | Reserved  |  |
| 0x20        | R   | 0x20    | VOUT_MODE               | 1         |   |   | le for programming the output voltage.  |  |
| 0x21        | R/W | 0x00    | VOUT_COMMAND            | 2         | Sets the  | output voltage using VI                                 | D.  |  |
| 0x25        | R/W | 0x0020  | VOUT_MARGIN_<br>HIGH    | 2         |   | e output voltage when ope<br>ogrammed in VID Mode.      | eration command is set to Margin  |  |
| 0x26        | R/W | 0x00B2  | VOUT_MARGIN_<br>LOW     | 2         |   | e output voltage when ope<br>ogrammed in VID Mode.      | eration command is set to Margin  |  |
| 0x38        | R/W | 0x0001  | IOUT_CAL_GAIN           | 2         |   | e ratio of voltage sensed t ssed in $1/\Omega$          | to current output. Scale is Linear and  |  |
| 0x39        | R/W | 0x0000  | IOUT_CAL_OFFSET         | 2         | This offs<br>circuitry.   | set is used to null out any<br>Programmed in Linear r   | offsets in the output current sensing node and units are Amps.  |  |
| 0x4A        | R/W | 0x0064  | IOUT_OC_WARN_<br>LIMIT  | 2         | IOUT_C  | OC_WARN_LIMIT bit is set<br>is generated. This limit is | Droe this limit is exceeded<br>et in the Status_IOUT register and an<br>a set in Amps and programmed in                               |  |
| 0x4F        | R/W | 0x0055  | OT_FAULT_LIMIT          | 2         | gets set  | in the Status_TEMPERA                                   | bove which the Over Temp Fault Bit<br>ATURE Register and the FAULT<br>s set using Linear Mode in °C.                                  |  |
| 0x51        | R/W | 0x0046  | OT_WARN_LIMIT           | 2         | gets set  |   | ove which the Over Temp Warn Bit<br>TURE Register and the ALERT Output<br>ng Linear Mode in °C.                                       |  |
| 0x52        | R/W | 0x0000  | UT_WARN_LIMIT           | 2         | This sets the temperature limit below which the Under Temp Warn<br>gets set in the Status_TEMPERATURE Register and the ALERT C<br>gets asserted. This limit is set using Linear Mode in °C. |   |   |  |
| 0x55        | R/W | 0x0010  | VIN_OV_FAULT LIMIT      | 2         | Overvol   | tage Fault Bit, Bit 7, gets                             | ault limit. Once exceeded the V <sub>IN</sub><br>set in the Status Input Register and<br>his limit is set using Linear Mode, in V.    |  |
| 0x57        | R/W | 0x0010  | VIN_OV_WARN LIMIT       | 2         | Overvol   | tage Warn Bit, Bit 6, gets                              | warn limit. Once exceeded the V <sub>IN</sub><br>set in the Status Input Register and<br>his limit is set using Linear Mode, in V.    |  |
| 0x58        | R/W | 0x0000  | VIN_UV_WARN LIMIT       | 2         | Undervo   | oltage Warn Bit, Bit 5, get                             | warn limit. Once exceeded the V <sub>IN</sub><br>is set in the Status Input Register and<br>nis limit is set using Linear Mode, in V. |  |
| 0x68        | R/W | 0x012C  | Pout_op_<br>Fault limit | 2         | of the St   | tatus I <sub>OUT</sub> Command gets                     | ower fault limit. Once exceeded Bit 1<br>s set and the FAULT output gets<br>it is set using Linear Mode in W.                         |  |
| 0x6A        | R/W | 0x012C  | POUT_OP<br>WARN LIMIT   | 2         | of the St   | tatus I <sub>OUT</sub> Command gets                     | ower warn limit. Once exceeded Bit 0<br>s set and the ALERT output gets<br>it is set using Linear Mode in W.                          |  |
| 0x78        | R   | 0x00    | STATUS BYTE             | 1         | Bit   | Name  | Comment   |  |
|             |     |         |                         |           | 7   | BUSY  | A fault was declared because the ADP4000 was busy and unable to respond.  |  |
|             |     |         |                         |           | 6   | OFF   | This bit is set whenever the<br>ADP4000 is not switching.   |  |
|             |     |         |                         |           | 5   | VOUT_OV   | This bit gets set whenever the ADP4000 goes into OVP mode.  |  |
|             |     |         |                         |           | 4   | IOUT_OC   | This bit gets set whenever the ADP4000 latches off due to an over current event.  |  |
|             |     |         |                         |           | 3   | VIN_UV  | This bit gets set when the input<br>voltage falls below its programmed<br>FAULT limit.  |  |
|             |     |         |                         |           | 2   | TEMP  | This bit gets set when the<br>Temperature, as measured using<br>the THERMISTOR, exceeds its<br>THERM and/or high or low limits.       |  |

| Cmd<br>Code | R/W | Default | Description             | #<br>Byte |      |         | Co                        | omment   |
|-------------|-----|---------|-------------------------|-----------|------|---------|---------------------------|--|
|             |     |         |                         |           | 1    | C       | CML                       | A Communications, memory or<br>logic fault has occurred.   |
|             |     |         |                         |           | 0    | None of | the Above                 | A fault has occurred which is not<br>one of the above.   |
| 0x79        | R   | 0x0000  | STATUS WORD             | 2         | Byte | Bit     | Name                      | Description  |
|             |     |         |                         |           | Low  | 7       | Res                       | Reserved   |
|             |     |         |                         |           | Low  | 6       | OFF                       | This bit is set whenever the ADP4000 is not switching.   |
|             |     |         |                         |           | Low  | 5       | VOUT<br>_OV               | This bit gets set whenever the ADP4000 goes into OVP mode.   |
|             |     |         |                         |           | Low  | 4       |                           | This bit gets set whenever the ADP4000 latches off due to an over current event.   |
|             |     |         |                         |           | Low  | 3       | Res                       | Reserved   |
|             |     |         |                         |           | Low  | 2       | TEMP                      | This bit gets set when the<br>Temperature, as measured using<br>the THERMISTOR, exceeds its<br>THERM and/or high or low limits.  |
|             |     |         |                         |           | Low  | 1       | CML                       | A Communications, memory or<br>logic fault has occurred.   |
|             |     |         |                         |           | Low  | 6       | None of<br>the Above      | A fault has occurred which is not one of the above.  |
|             |     |         |                         |           | High | 7       | V <sub>OUT</sub>          | This bit gets set whenever the<br>measured output voltage goes<br>outside its power good limits or an<br>OVP event has taken place, i.e.<br>any bit in Status V <sub>OUT</sub> is set. |
|             |     |         |                         |           | High | 6       | lout/Pout                 | This bit gets set whenever the<br>measured output current or power<br>exceeds its warning limit or goes<br>into OCP. i.e. any bit in Status I <sub>OUT</sub><br>is set.                |
|             |     |         |                         |           | High | 5       | INPUT                     | This bit gets set if the input voltage,<br>as measured on VSENSE1 goes<br>outside its programmed limits. i.e.<br>any bit in Status V <sub>INPUT</sub> is set.                          |
|             |     |         |                         |           | High | 4       | MFR                       | A manufacturer specific warning or fault has occurred.   |
|             |     |         |                         |           | High | 3       | POWER<br>_GOOD            | The Power–Good signal is<br>deasserted. Same as Power–Good<br>in General Status.   |
|             |     |         |                         |           | High | 2       | Res                       | Reserved   |
|             |     |         |                         |           | High | 1       | OTHER                     | A Status bit in Status Other is asserted.  |
|             |     |         |                         |           | High | 0       | Res                       | Reserved   |
| 0x7A        | R   | 0x00    | STATUS V <sub>OUT</sub> | 1         | Bit  | N       | ame                       | Description  |
|             |     |         |                         |           | 7    | OVER    | DUT_<br>VOLTAGE<br>AULT   | This bit gets set whenever an OVP<br>Event takes place.  |
|             |     |         |                         |           | 6    | OVER    | DUT_<br>/OLTAGE<br>RNING  | This bit gets set whenever the<br>measured output voltage goes<br>above its Power-Good limit.  |
|             |     |         |                         |           | 5    | UNDER   | DUT_<br>IVOLTAGE<br>RNING | This bit gets set whenever the measured output voltage goes below its Power-Good limit.  |
|             |     |         |                         |           | 4    | UNDER   | DUT_<br>IVOLTAGE<br>AULT  | Not applicable.  |

| Cmd<br>Code | R/W | Default | Description             | #<br>Byte |     | Co                                      | omment  |
|-------------|-----|---------|-------------------------|-----------|-----|---|---|
|             |     |         |                         |           | 3   | VOUT_MAX<br>Warning                     | Not supported, Can't program an<br>output greater than max VID as<br>there are no bits to program it.                                       |
|             |     |         |                         |           | 2   | TON_MAX_FAULT                           | Not supported.  |
|             |     |         |                         |           | 1   | TOFF_MAX_<br>WARNING                    | Not supported.  |
|             |     |         |                         |           | 0   | VOUT_TRACKING_<br>ERROR                 | Not supported.  |
| 0x7B        | R   | 0x00    | STATUS I <sub>OUT</sub> | 1         | Bit | Name                                    | Description   |
|             |     |         |                         |           | 7   | I <sub>OUT</sub> Overcurrent<br>Fault   | This bit gets set if the ADP4000 latches off due to an OCP Event.   |
|             |     |         |                         |           | 6   | Reserved                                | Reserved  |
|             |     |         |                         |           | 5   | I <sub>OUT</sub> Overcurrent<br>Warning | This bit gets set if I <sub>OUT</sub> exceeds its<br>programmed high warning limit.   |
|             |     |         |                         |           | 4   | Reserved                                | Reserved  |
|             |     |         |                         |           | 3   | Reserved                                | Reserved  |
|             |     |         |                         |           | 2   | Reserved                                | Reserved  |
|             |     |         |                         |           | 1   | POUT Over-Power<br>Fault                | This bit gets set if the measured POUT exceeds the FAULT Limit.   |
|             |     |         |                         |           | 0   | POUT Over-Power<br>Warning              | This bit gets set if the measured POUT exceeds the Warn Limit.  |
| 0x7C        | R   | 0x00    | STATUS INPUT            | 1         | Bit | Name                                    | Description   |
|             |     |         |                         |           | 7   | V <sub>IN</sub> Overvoltage<br>FAULT    | This bit gets set when the input<br>voltage goes above its<br>programmed FAULT limit.   |
|             |     |         |                         |           | 6   | V <sub>IN</sub> Overvoltage<br>Warning  | This bit gets set when the input<br>voltage goes above its<br>programmed high limit.  |
|             |     |         |                         |           | 5   | Undervoltage<br>Warning                 | This bit gets set when the input<br>voltage falls below its programmed<br>low limit.  |
|             |     |         |                         |           | 4   | Reserved                                | Reserved  |
|             |     |         |                         |           | 3   | Reserved                                | Reserved  |
|             |     |         |                         |           | 2   | Reserved                                | Reserved  |
|             |     |         |                         |           | 1   | Reserved                                | Reserved  |
|             |     |         |                         |           | 0   | Reserved                                | Reserved  |
| 0x7D        | R   | 0x00    | STATUS_                 | 1         | Bit | Name                                    | Description   |
|             |     |         | TEMPERATURE             |           | 7   | Overtemperature<br>FAULT                | This bit gets asserted when the temperature measured by the Thermistor connected to TTSENSE exceeds its THERM/FAULT Limit.                  |
|             |     |         |                         |           | 6   | Overtemperature<br>Warrning             | This bit gets asserted when the<br>temperature measured by the<br>Thermistor connected to TTSENSE<br>exceeds its High Temperature<br>Limit. |
|             |     |         |                         |           | 5   | Undertemperature<br>Warrning            | This bit gets asserted when the temperature measured by the Thermistor connected to TTSENSE exceeds its Low Temperature Limit.              |
|             |     |         |                         |           | 4   | Reserved                                | Reserved  |
|             |     |         |                         |           | 3   | Reserved                                | Reserved  |
|             |     |         |                         |           | 2   | Reserved                                | Reserved  |
|             |     |         |                         |           | 1   | Reserved                                | Reserved  |
|             |     |         |                         |           | 0   | Reserved                                | Reserved  |

| Cmd<br>Code | R/W | Default | Description          | #<br>Byte |     |                      | Co   | omment   |
|-------------|-----|---------|----------------------|-----------|-----|----------------------|--|--|
| 0x7E        | R   | 0x00    | STATUS CML           | 1         | Bit | Na                   | ame  | Description  |
|             |     |         |                      |           | 7   | Unsu                 | alid or<br>pported<br>d Received                 | Supported  |
|             |     |         |                      |           | 6   | Unsupp               | alid or<br>orted Data<br>ceived                  | Supported  |
|             |     |         |                      |           | 5   | PEC                  | Failed   | Supported  |
|             |     |         |                      |           | 4   |                      | ory Fault<br>tected                              | Not Supported  |
|             |     |         |                      |           | 3   |                      | sor Fault<br>tected                              | Not Supported  |
|             |     |         |                      |           | 2   | Res                  | served   | Reserved   |
|             |     |         |                      |           | 1   | fault oth<br>ones li | nunication<br>er than the<br>isted has<br>urred. | Supported  |
|             |     |         |                      |           | 0   | Logic F              | nemory or<br>Fault has<br>urred.                 | Not Supported  |
| 0x80        | R   | 0x00    | STATUS_ALERT         | 1         | Bit | Na                   | ame  | Description  |
|             |     |         |                      |           | 7   | Res                  | served   | Reserved   |
|             |     |         |                      |           | 6   | Res                  | served   | Reserved   |
|             |     |         |                      |           | 5   | VSENS                | E2 FAULT   | Gets asserted when VSENSE2<br>exceeds it programmed FAULT<br>limits.   |
|             |     |         |                      |           | 4   |                      | ISE2 OV<br>ARN                                   | Gets asserted when VSENSE2<br>exceeds it programmed OV WARN<br>limits. |
|             |     |         |                      |           | 3   |                      | ISE2 OV<br>ARN                                   | Gets asserted when VSENSE2<br>exceeds it programmed UV WARN<br>limits. |
|             |     |         |                      |           | 2   | VMON                 | N WARN   | Gets asserted when VSENSE2<br>exceeds it programmed WARN<br>limits.    |
|             |     |         |                      |           | 1   | VMON                 | N FAULT  | Gets asserted when VSENSE2<br>exceeds it programmed FAULT<br>limits.   |
|             |     |         |                      |           | 0   | Res                  | served   | Reserved   |
| 0x88        | R   | 0x00    | READ_VIN             | 2         |     |                      |  | je (measured using VSENSE1).<br>n Linear Mode                          |
| 0x8B        | R   | 0x00    | READ_VOUT            | 2         |     | Readbac              | k output volta                                   | age. Voltage is read back in VID Mode.                                 |
| 0x8C        | R   | 0x00    | READ_IOUT            | 2         |     | Readbac<br>Mode (Ar  |  | ent. Current is read back in Linear                                    |
| 0x8D        | R   | 0x00    | READ<br>TEMPERATURE1 | 2         |     |                      |  | e 1. Thermistor, connected to<br>e element. Temperature is read back   |
| 0x96        | R   | 0x00    | READ_POUT            | 2         |     | Readback             | k Output Powe                                    | er, read back in Linear Mode in W's.                                   |
| 0x99        | R   | 0x41    | MFR_ID               | 1         |     | 0x41                 | Readback<br>Byte count                           | using the Block command with the equal to 1.                           |
| 0x9A        | R   | 0x4000  | MFR_MODEL            | 2         |     | 0x4000               | Readback<br>Byte count                           | using the Block command with the equal to 2.                           |
| 0x9B        | R   | 0x01    | MFR_REVISION         | 1         |     | 0                    |  | using the Block command with the equal to 1.                           |

| Cmd<br>Code | R/W | Default | Description  | #<br>Byte |     |                      | Comment   |
|-------------|-----|---------|--------------|-----------|-----|----------------------|---|
| 0xD0        | R/W | 0x00    | Lock/Reset   | 1         | Bit | Name                 | Description   |
|             |     |         |              |           | 1   | Reset                | Resets all registers to their POR Value.<br>Has no effect if Lock bit is set.   |
|             |     |         |              |           | 0   | Lock                 | Logic 1 locks all limit values to their<br>current settings. Once this bit is set, all<br>lockable registers become read-only<br>and cannot be modified until the<br>ADP4000 is powered down and<br>powered up again. This prevents rogue<br>programs such as viruses from<br>modifying critical system limit settings<br>(Lockable).   |
| 0xD1        | R/W | 0x07    | Mfr Config   | 1         | Bit | Name                 | Description   |
|             |     |         |              |           | 7:6 | PSI                  | These bits sets the number of phases<br>turned on during PSI.<br>00 = 1 Phase enabled during PSI<br>01 = 2 Phases enabled during PSI<br>10 = 3 Phases enabled during PSI<br>11 = 1 Phase enabled during PSI   |
|             |     |         |              |           | 5   | Reserved             | Reserved  |
|             |     |         |              |           | 4   | Reserved             | Reserved  |
|             |     |         |              |           | 3   | BUS_TO_EN            | Bus Timeout Enable. When the<br>BUS_TO_EN bit is set to 1, the I <sup>2</sup> C<br>Timeout feature is enabled. In this state<br>if, at any point during an I <sup>2</sup> C transaction<br>involving the ADP4000, activity ceases<br>for more than 35 ms, the ADP4000<br>assumes the bus is locked and releases<br>the bus. This allows the ADP4000 to be<br>used with SMBus controllers that cannot<br>handle SMBus timeouts (Lockable). |
|             |     |         |              |           | 2   | FAULT_EN             | Enable the $\overline{FAULT}$ pin, Default = 1  |
|             |     |         |              |           | 1   | ALERT_EN             | Enable the ALERT pin  |
|             |     |         |              |           | 0   | ENABLE_<br>MONITOR   | When the ENABLE_MONITOR bit is set<br>to 1, the ADP4000 starts conversions<br>with the ADC and monitors the voltages<br>and temperatures.   |
| 0xD2        | R/W | 0x52    | VR Config 1A | 1         | Bit | Name                 | Description   |
|             |     |         |              |           | 6:4 | Phase Enable<br>Bits | 000 = Phase 1<br>001 = Phase 2<br>010 = Phase 3<br>011 = Phase 4<br>100 = Phase 5<br>101 = Phase 6<br>All other codes = Phase 6   |
|             |     |         |              |           | 3   | VID_EN               | When the VID_EN bit is set to 1, the VID<br>code in the VOUT_COMMAND register<br>sets the output voltage. When VID_EN is<br>set to 0, the output voltage follows the<br>VID input pins.   |
|             |     |         |              |           | 2   | LOOP_EN              | When the LOOP_EN bit is set to 1 in<br>both registers, the control loop test<br>function is enabled. This allows<br>measurement of the control loop AC<br>gain and phase response with<br>appropriate instrumentation. The control<br>loop signal insertion pin is IMON. The<br>control loop output pin is COMP.  |

## Table 12. Manufacturer Specific Command Codes for the ADP4000

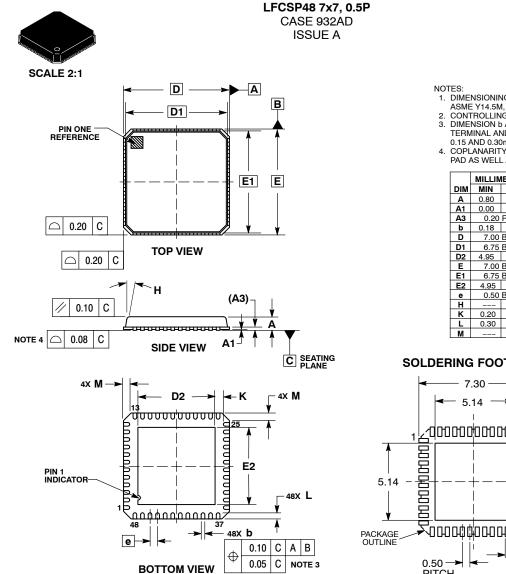
| Cmd<br>Code | R/W | Default | Description           | #<br>Byte | Comment  |  |   |
|-------------|-----|---------|-----------------------|-----------|--|--|---|
|             |     |         |                       |           | 1  | CLIM_EN  | When CLIM_EN is set to 1, the current<br>limit time out latchoff functions normally.<br>When this bit is set to 0 in both<br>registers, the current limit latchoff is<br>disabled. In this state, the part can be in<br>current limit indefinitely. |
|             |     |         |                       |           | 0  | Reserved   | Reserved  |
| 0xD3        | R/W | 0x52    | VR Config 1B          | 1         | This register is for security reasons. It has the same format as register 0xD2. Bits need to be set in both registers for the function to take effect.   |  |   |
| 0xD4        | R/W | 0x03    | Ton Delay             | 1         | This resister sets TD1, TD3 and TD5 delays for the soft-start<br>sequence. The current limit latchoff timer is 4 times the programmed<br>delay time.<br>000 = 0.5  ms<br>001 = 1  ms<br>010 = 1.5  ms<br>011 = 2  ms = default<br>100 = 2.5  ms<br>101 = 3  ms<br>110 = 3.5  ms<br>111 = 4  ms |  |   |
| 0xD5        | R/W | 0x02    | Ton Rise              | 1         | and T<br>000 =<br>001 =<br>010 =<br>011 =<br>100 =<br>101 =<br>110 =   | egister sets the soft-<br>TD4, of the soft-start<br>0.1 V/ms<br>0.3 V/ms<br>0.5 V/ms = default<br>0.7 V/ms<br>0.9 V/ms<br>1.1 V/ms<br>1.3 V/ms<br>1.5 V/ms | -start voltage slew rate, and hence TD2<br>sequence.  |
| 0xD6        | R/W | 0x01    | Ton Transition        | 1         | 000 =<br>001 =<br>010 =<br>011 =<br>100 =<br>101 =<br>110 =  | egister sets the slew<br>1 V/ms<br>3 V/ms = default<br>5 V/ms<br>7 V/ms<br>9 V/ms<br>11 V/ms<br>13 V/ms<br>15 V/ms   | rate during a dynamic VID.  |
| 0xD7        | R   | 0x00    | VSENSE2 Voltage       | 2         | This is a 16 bit value that reports back the voltage on the VSENSE2<br>Pin. Can be configured to measure the input Voltage Current. 16 Bit<br>Value between 0 and 2.0 V. Voltage is reported using Linear Mode.  |  |   |
| 0xD8        | R   | 0x00    | EN/VTT Voltage        | 2         | This is a 16 bit value that reports back the voltage on the VTT Pin.<br>Voltage is reported using Linear Mode.   |  |   |
| 0xDA        | R   | 0x00    | VMON Voltage          | 2         |  |  | reports back the voltage measured<br>Voltage is reported using Linear Mode.   |
| 0xDB        | R/W | 0x00    | VOUT_TRIM             | 1         | Offse  | t Command Code for   | r V <sub>OUT</sub> , max ±200 mV.   |
| 0xDC        | R/W | 0x00    | VOUT_CAL              | 1         | Offset Command Code for V <sub>OUT</sub> , max ±200 mV.  |  | r V <sub>OUT</sub> , max ±200 mV.   |
| 0xDE        | R/W | 0x10    | Load Line Calibration | 1         | value<br>gain<br>sectio<br>0% ir<br>line.<br>0000<br>1000  | e. The maximum load<br>of the current sense<br>on. This maximum loa  |   |
| 0xDF        | R/W | 0x00    | Load Line Set         | 1         | maxir<br>curre<br>maxir<br>steps<br>0000<br>1000   | num load line is cont<br>nt sense amplifier as<br>num load line can the  |   |

| Cmd<br>Code | R/W | Default | Description             | #<br>Byte | Comment   |  |
|-------------|-----|---------|-------------------------|-----------|---|--|
| 0xE0        | R/W | 0x00    | PWRGD Hi Threshold      | 1         | This value sets the PWRGD Hi Threshold and the CROWBAR<br>Threshold:<br>Code = 00, PWRGD HI = 300 mV (default)<br>Code = 01, PWRGD HI = 250 mV<br>Code = 10, PWRGD HI = 200 mV<br>Code = 11, PWRGD HI = 150 mV  |  |
| 0xE1        | R/W | 0x00    | PWRGD Lo Threshold      | 1         | This value sets the PWRGD Lo Threshold:<br>Code = 000, PWRGD Lo = -500 mV (default)<br>Code = 001, PWRGD Lo = -450 mV<br>Code = 010, PWRGD Lo = -400 mV<br>Code = 011, PWRGD Lo = -350 mV<br>Code = 100, PWRGD Lo = -300 mV<br>Code = 101, PWRGD Lo = -250 mV<br>Code = 110, PWRGD Lo = -200 mV<br>Code = 111, PWRGD Lo = -150 mV   |  |
| 0xE2        | R/W | 0x10    | Current Limit Threshold | 1         | This value sets the internal current limit adjust value. The default<br>current limit is programmed using a resistor to ground on the LIMIT<br>pin. The value of this register adjusts this value by a percentage<br>between 50% and 146.7%. Each LSB represents a 3.33% change in<br>the threshold.<br>11111 = 146.7% of external current limit<br>10000 = 100% of external current limit<br>00000 = 50% of external current limit |  |
| 0xE3        | R/W | 0x10    | Phase Bal SW1           | 1         | These values adjust the gain of the internal phase balance<br>amplifiers. The nominal gain is set to 5. These registers can adjust<br>the gain by ±25% from 3.75 to 6.25.<br>Code = 00000, Gain of 3.75<br>Code = 10000, Gain of 5 (default)<br>Code = 11111, Gain of 6.25  |  |
| 0xE4        | R/W | 0x10    | Phase Bal SW2           | 1         | These values adjust the gain of the internal phase balance<br>amplifiers. The nominal gain is set to 5. These registers can adjust<br>the gain by ±25% from 3.75 to 6.25.<br>Code = 00000, Gain of 3.75<br>Code = 10000, Gain of 5 (default)<br>Code = 11111, Gain of 6.25  |  |
| 0xE5        | R/W | 0x10    | Phase Bal SW3           | 1         | These values adjust the gain of the internal phase balance<br>amplifiers. The nominal gain is set to 5. These registers can adjust<br>the gain by ±25% from 3.75 to 6.25.<br>Code = 00000, Gain of 3.75<br>Code = 10000, Gain of 5 (default)<br>Code = 11111, Gain of 6.25  |  |
| 0xE6        | R/W | 0x10    | Phase Bal SW4           | 1         | These values adjust the gain of the internal phase balance<br>amplifiers. The nominal gain is set to 5. These registers can adjust<br>the gain by $\pm 25\%$ from 3.75 to 6.25.<br>Code = 00000, Gain of 3.75<br>Code = 10000, Gain of 5 (default)<br>Code = 11111, Gain of 6.25  |  |
| 0xE7        | R/W | 0x10    | Phase Bal SW5           | 1         | These values adjust the gain of the internal phase balance<br>amplifiers. The nominal gain is set to 5. These registers can adjust<br>the gain by $\pm 25\%$ from 3.75 to 6.25.<br>Code = 00000, Gain of 3.75<br>Code = 10000, Gain of 5 (default)<br>Code = 11111, Gain of 6.25  |  |
| 0xE8        | R/W | 0x10    | Phase Bal SW6           | 1         | These values adjust the gain of the internal phase balance<br>amplifiers. The nominal gain is set to 5. These registers can adjust<br>the gain by $\pm 25\%$ from 3.75 to 6.25.<br>Code = 00000, Gain of 3.75<br>Code = 10000, Gain of 5 (default)<br>Code = 11111, Gain of 6.25  |  |
| 0xEE        | R/W | 0x0050  | VRHOT RESET LIMIT       | 2         | This is the temperature below which the VTHOT will de-assert.   |  |
| 0xEF        | R/W | 0x0002  | VSENSE2 High Limit      | 2         | VSENSE2 voltage high limit.   |  |
| 0xF0        | R/W | 0x0000  | VSENSE2 Low Limit       | 2         | VSENSE2 voltage low limit.  |  |
| 0xF1        | R/W | 0x0002  | VSENSE2 FAULT Limit     | 2         | VSENSE2 voltage FAULT limit.  |  |
| 0xF5        | R/W | 0x0002  | VMON FAULT Limit        | 2         | VMON FAULT Limit.   |  |

| Cmd<br>Code | R/W | Default | Description     | #<br>Byte | Comment  |                       |   |  |
|-------------|-----|---------|-----------------|-----------|--|-----------------------|---|--|
| 0xF6        | R/W | 0x0002  | VMON Warn Limit | 2         | VMON Warn Limit.   |                       |   |  |
| 0xF7        | R/W | 0x07CE  | TTSENSE Gain    | 2         | Gain information used to convert TTSENSE Voltage to temperature.   |                       |   |  |
| 0xF8        | R/W | 0x007B  | TTSENSE Offset  | 2         | Offset information used to convert TTSENSE Voltage to temperature. |                       |   |  |
| 0xF9        | R/W | 0x00    | Mask ALERT      | 1         | Bit  | Name                  | Description   |  |
|             |     |         |                 |           | 7  | Mask V <sub>OUT</sub> | Masks any ALERT caused by bits in Status V <sub>OUT</sub> Register. |  |
|             |     |         |                 |           | 6  | Mask I <sub>OUT</sub> | Masks any ALERT caused by bits in Status I <sub>OUT</sub> Register. |  |
|             |     |         |                 |           | 5  | Mask Input            | Masks any ALERT caused by bits in Status Input Register.            |  |
|             |     |         |                 |           | 4  | Mask<br>Temperature   | Masks any ALERT caused by bits in Status Temperature Register.      |  |
|             |     |         |                 |           | 3  | Mask CML              | Masks any ALERT caused by bits in Status CML Register.              |  |
|             |     |         |                 |           | 2  | VMON                  | Masks any ALERT caused by VMON exceeding its high or low limit.     |  |
|             |     |         |                 |           | 1  | VSENSE2               | Masks any ALERT caused by VSENSE2 exceeding its high or low limit.  |  |
|             |     |         |                 |           | 0  | Mask POUT             | Masks any ALERT caused by POUT exceeding its programmed limit.      |  |
| 0xFA        | R/W | 0x00    | Mask FAULT      | 1         | Bit  | Name                  | Description   |  |
|             |     |         |                 |           | 7  | Mask V <sub>OUT</sub> | Masks any FAULT caused by bits in Status V <sub>OUT</sub> Register. |  |
|             |     |         |                 |           | 6  | Mask I <sub>OUT</sub> | Masks any FAULT caused by bits in Status I <sub>OUT</sub> Register. |  |
|             |     |         |                 |           | 5  | Mask Input            | Masks any FAULT caused by bits in Status Input Register.            |  |
|             |     |         |                 |           | 4  | Mask<br>Temperature   | Masks any FAULT caused by bits in Status Temperature Register.      |  |
|             |     |         |                 |           | 3  | Mask CML              | Masks any FAULT caused by bits in Status CML Register.              |  |
|             |     |         |                 |           | 2  | VMON                  | Masks any FAULT caused by VMON exceeding its high or low limit.     |  |
|             |     |         |                 |           | 1  | VSENSE2               | Masks any FAULT caused by VSENSE2 exceeding its high or low limit.  |  |
|             |     |         |                 |           | 0  | Mask POUT             | Masks any FAULT caused by POUT exceeding its programmed limit.      |  |
| 0xFB        | R/W | 0x00    | General Status  | 1         | Bit  | Name                  | Description   |  |
|             |     |         |                 |           | 7  | FAULT                 |   |  |
|             |     |         |                 |           | 6  | ALERT                 |   |  |
|             |     |         |                 |           | 5  | POWER-GOOD            | Replaced by Bit 3 of the Status Word Command.                       |  |
|             |     |         |                 |           | 4  | RDY                   |   |  |
| 0xFC        | R   | 0x00    | Phase Status    | 1         | Bit  | Name                  | Description   |  |
|             |     |         |                 |           | 7  | Phase 6               | This bit is set to 1 when Phase 6 is enabled.                       |  |
|             |     |         |                 |           | 6  | Phase 5               | This bit is set to 1 when Phase 5 is enabled.                       |  |
|             |     |         |                 |           | 5  | Phase 4               | This bit is set to 1 when Phase 4 is enabled.                       |  |
|             |     |         |                 |           | 4  | Phase 3               | This bit is set to 1 when Phase 3 is enabled.                       |  |
|             |     |         |                 |           | 3  | Phase 2               | This bit is set to 1 when Phase 2 is enabled.                       |  |

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# semi

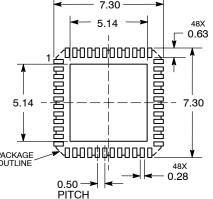


DATE 23 JAN 2009

- NOTES: 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994. 2. CONTROLLING DIMENSIONS: MILLIMETERS. 3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30mm FROM THE TERMINAL TIP. CONDUCTOR DUPLIES TO FLIC EXPOSED
- COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

|     | MILLIMETERS |      |  |  |  |  |  |
|-----|-------------|------|--|--|--|--|--|
| DIM | MIN         | MAX  |  |  |  |  |  |
| Α   | 0.80        | 1.00 |  |  |  |  |  |
| A1  | 0.00        | 0.05 |  |  |  |  |  |
| A3  | 0.20 REF    |      |  |  |  |  |  |
| b   | 0.18        | 0.30 |  |  |  |  |  |
| D   | 7.00        | BSC  |  |  |  |  |  |
| D1  | 6.75 BSC    |      |  |  |  |  |  |
| D2  | 4.95        | 5.25 |  |  |  |  |  |
| Е   | 7.00 BSC    |      |  |  |  |  |  |
| E1  | 6.75 BSC    |      |  |  |  |  |  |
| E2  | 4.95        | 5.25 |  |  |  |  |  |
| е   | 0.50 BSC    |      |  |  |  |  |  |
| Н   |             | 12°  |  |  |  |  |  |
| Κ   | 0.20        |      |  |  |  |  |  |
| L   | 0.30        | 0.50 |  |  |  |  |  |
| М   |             | 0.60 |  |  |  |  |  |

SOLDERING FOOTPRINT\*



DIMENSIONS: MILLIMETERS

\*For additional information on our Pb-Free strategy and soldering details, please download the onsemi Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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|                  |                    |   |             |  |  |  |

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